











ADS7038

SBAS979 - JUNE 2019

ADS7038 Small, 8-Channel, 12-Bit ADC With SPI Interface, GPIOs, and CRC

1 Features

- Small package size:
 - WQFN 3 mm x 3 mm
- 8 channels configurable as any combination of:
 - Up to 8 analog inputs, digital inputs, or digital outputs
- GPIOs for I/O expansion:
 - Open-drain, push-pull digital outputs
- · Analog watchdog:
 - Programmable thresholds per channel
 - Event counter for transient rejection
- Wide operating ranges:
 - AVDD: 2.35 V to 5.5 V
 - DVDD: 1.65 V to 5.5 V
 - –40°C to +125°C temperature range
- Enhanced-SPI digital interface:
 - High-speed, 60-MHz interface
 - Achieve full throughput with >13.5-MHz SPI
- CRC for read/write operation:
 - CRC on data read/write
 - CRC on power-up configuration
- Programmable averaging filters:
 - Programmable sample size for averaging
 - Averaging with internal conversions
 - 16-bit resolution

2 Applications

- Supervisory functions
- Portable instrumentation
- · Telecommunication infrastructure
- · Power-supply monitoring

3 Description

The ADS7038 is an easy-to-use, 8-channel, multiplexed, 1-MSPS, 12-bit, successive approximation register analog-to-digital converter The ADC). eight channels can independently configured as either analog inputs, digital inputs, or digital outputs. The device has an internal oscillator for the ADC conversion process.

The ADS7038 communicates via an SPI-compatible interface and operates in either autonomous or single-shot conversion mode. The ADS7038 implements the analog watchdog function by event-triggered interrupts per channel using a digital window comparator with programmable high and low thresholds, hysteresis, and an event counter. The ADS7038 has a built-in cyclic redundancy check (CRC) for data read/write operations and the power-up configuration.

Device Information(1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
ADS7038	WQFN (16)	3.00 mm × 3.00 mm

For all available packages, see the orderable addendum at the end of the datasheet.

ADS7038 Block Diagram and Applications

Device Block Diagram

AVDD DECAF High/Low Threshold Digital Window AIN0 / GPIO0 Programmable AIN1 / GPIO1 ADC Averaging Filters AIN2 / GPIO2 AIN3 / GPIO3 cs SPI Interface AIN4 / GPIO4 SCLK and CRC AIN5 / GPIO5 Pin CFG SDI AIN6 / GPIO6 SDO GPO Write AIN7 / GPIO7 GPI Read

Example System Architecture

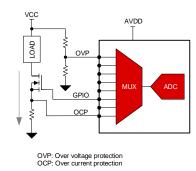




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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
June 2019	*	Initial release.

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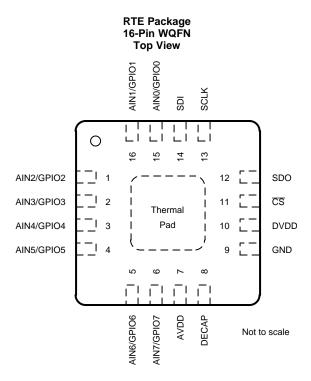
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5 Device Comparison Table

PART NUMBER	DESCRIPTION	CRC MODULE	ZERO-CROSSING-DETECT (ZCD) MODULE	ROOT-MEAN-SQUARE (RMS) MODULE
ADS7028	8-channel, 12-bit ADC with SPI interface and GPIOs	Yes	Yes	Yes
ADS7038		Yes	No	No
ADS7038-Q1		Yes	No	No



6 Pin Configuration and Functions



Pin Functions

D 111			1 III I dilotions
PIN		FUNCTION ⁽¹⁾	DESCRIPTION
NAME	NO.		520010H 11011
AIN0/GPIO0	15	AI, DI, DO	Channel 0; can be configured as either an analog input (default), digital input, or digital output.
AIN1/GPIO1	16	AI, DI, DO	Channel 1; can be configured as either an analog input (default), digital input, or digital output.
AIN2/GPIO2	1	AI, DI, DO	Channel 2; can be configured as either an analog input (default), digital input, or digital output.
AIN3/GPIO3	2	AI, DI, DO	Channel 3; can be configured as either an analog input (default), digital input, or digital output.
AIN4/GPIO4	3	AI, DI, DO	Channel 4; can be configured as either an analog input (default), digital input, or digital output.
AIN5/GPIO5	4	AI, DI, DO	Channel 5; can be configured as either an analog input (default), digital input, or digital output.
AIN6/GPIO6	5	AI, DI, DO	Channel 6; can be configured as either an analog input (default), digital input, or digital output.
AIN7/GPIO7	6	AI, DI, DO	Channel 7; can be configured as either an analog input (default), digital input, or digital output.
AVDD	7	Supply	Analog supply input, also used as the reference voltage to the ADC; connect a 1-µF decoupling capacitor to GND.
cs	11	DI	Chip-select input pin; active low. The device takes control of the data bus when \overline{CS} is low. The device starts converting the active input channel on the rising edge of \overline{CS} . SDO goes hi-Z when \overline{CS} is high.
DECAP	8	Supply	Connect a decoupling capacitor to this pin for the internal power supply.
DVDD	10	Supply	Digital I/O supply voltage; connect a 1-µF decoupling capacitor to GND.
GND	9	Supply	Ground for the power supply; all analog and digital signals are referred to this pin voltage.
SCLK	13	DI	Serial clock for the SPI interface.
SDI	14	DI	Serial data in for the device.
SDO	12	DO	Serial data out for the device.

(1) Al = analog input, DI = digital input, and DO = digital output.



7 Specifications

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7.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)(1)

	MIN	MAX	UNIT
DVDD to GND	-0.3	5.5	V
AVDD to GND	-0.3	5.5	V
AINx / GPOx ⁽²⁾ to GND	GND - 0.3	AVDD + 0.3	V
Digital input to GND	GND - 0.3	5.5	V
Current through any pin except supply pins (3)	-10	10	mA
Junction temperature, T _J	-40	125	°C
Storage temperature, T _{stg}	-60	150	°C

⁽¹⁾ Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
V _(ESD) Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	±2000		
V(ESD)	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾	±500	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER	SUPPLY					
AVDD	Analog supply voltage		2.35	3.3	5.5	V
DVDD	Digital supply voltage		1.65	3.3	5.5	V
ANALO	G INPUTS					
FSR	Full-scale input range	AIN _X - GND	0		AVDD	V
V _{IN}	Absolute input voltage	AIN _X - GND	-0.1	Д	VDD + 0.1	V
TEMPER	RATURE RANGE					
T _A	Ambient temperature		-40	25	125	°C

⁽¹⁾ AINx refers to AIN0, AIN1, AIN2, AIN3, AIN4, AIN5, AIN6, and AIN7.

7.4 Thermal Information

		ADS7038	
	THERMAL METRIC ⁽¹⁾	RTE (WQFN)	UNIT
		16 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	49.7	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	53.4	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	24.7	°C/W
Ψ_{JT}	Junction-to-top characterization parameter	1.3	°C/W
Ψ_{JB}	Junction-to-board characterization parameter	24.7	°C/W
R ₀ JC(bot)	Junction-to-case (bottom) thermal resistance	9.3	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

⁾ AINx / GPIOx refers to pins 1, 2, 3, 4, 5, 6, 15, and 16.

Pin current must be limited to 10mA or less.

²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



7.5 Electrical Characteristics

at AVDD = 5 V, DVDD = 1.65 V to 5.5 V, and maximum throughput (unless otherwise noted); minimum and maximum values at $T_{\Delta} = -40^{\circ}$ C to +125°C; typical values at $T_{\Delta} = 25^{\circ}$ C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALO	G INPUTS					
C _{SH}	Sampling capacitance			12		pF
DC PER	RFORMANCE		•			
	Resolution	No missing codes		12		bits
DNL	Differential nonlinearity		-0.9	±0.2	0.9	LSB
INL	Integral nonlinearity		-2	±0.5	2	LSB
V _(OS)	Input offset error	Post offset calibration	-2	±0.3	2	LSB
	Input offset thermal drift	Post offset calibration		±5		ppm/°C
	Offset error match		-1	±0.5	1	LSB
G _E	Gain error		-0.1	±0.05	0.1	%FSR
	Gain error thermal drift			±5		ppm/°C
	Gain error match		-0.05	±0.01	0.05	%FSR
AC PER	RFORMANCE		•			
CINIAD	Circulto naine e distantia e natio	AVDD = 5 V, f _{IN} = 2 kHz	68.5	71.5		40
SINAD	Signal-to-noise + distortion ratio	AVDD = 3 V, f _{IN} = 2 kHz	67.5	70.5		dB
CND	Circulto naise natio	AVDD = 5 V, f _{IN} = 2 kHz	69	72		40
SNR	Signal-to-noise ratio	AVDD = 3 V, f _{IN} = 2 kHz	68	71		dB
THD	Total harmonic distortion	f _{IN} = 2 kHz		-85		dB
SFDR	Spurious-free dynamic range	f _{IN} = 2-kHz		91		dB
	Isolation crosstalk	f _{IN} = 100 kHz		-100		dB
DECAP	Pin		•			
	Decoupling capacitor on DECAP pin		0.1	1		μF
SPI INT	ERFACE (CS, SCLK, SDI, SDO)					
V _{IH}	Input high logic level		0.7 x DVDD		5.5	V
V_{IL}	Input low logic level		-0.3		0.3 x DVDD	V
V	Output high lastic lastel	Source current = 2 mA, DVDD > 2 V	0.8 x DVDD		DVDD	V
V _{OH}	Output high logic level	Source current = 2 mA, DVDD ≤ 2 V	0.7 x DVDD		DVDD	V
\/	Output low logic lovel	Sink current = 2 mA, DVDD > 2 V	0		0.4	
V_{OL}	Output low logic level	Sink current = 2 mA, DVDD ≤ 2 V	0		0.2 x DVDD	V
GPIOs						
V_{IH}	Input high logic level		0.7 x AVDD		AVDD + 0.3	V
V_{IL}	Input low logic level		-0.3		0.3 x AVDD	V
	Input leakge current	GPIO configured as input		10	100	nA
V _{OH}	Output high logic level	GPO_DRIVE_CFG = push-pull, I _{SOURCE} = 2 mA	0.8 x AVDD		AVDD	V
V _{OL}	Output low logic level	I _{SINK} = 2 mA	0		0.2 x AVDD	V
I _{OH}	Output high source current	V _{OH} > 0.7 x AVDD			5	mA
I _{OL}	Output low sink current	V _{OL} < 0.3 x AVDD			5	mA
POWER	R-SUPPLY CURRENTS		1			
		Full throughput, AVDD = 5 V			2.66	
I _{AVDD}	Analog supply current	Full throughput, AVDD = 3 V			1.65	mA
-	-	No conversion, AVDD = 5 V		0.03	0.05	1

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7.6 Timing Requirements

at AVDD = 5 V, DVDD = 1.65 V to 5.5 V, and maximum throughput (unless otherwise noted); minimum and maximum values at $T_A = -40$ °C to +125°C; typical values at $T_A = 25$ °C

		MIN	MAX	UNIT
CONVERSI	ON CYCLE			
f _{CYCLE}	Sampling frequency		1000	kSPS
t _{CYCLE}	ADC cycle-time period	1 / f _{CYCLE}		S
t _{ACQ}	Acquisition time	300		ns
t _{QT_ACQ}	Quiet acquisition time	10		ns
t _{D_CNVCAP}	Quiet conversion time	10		ns
t _{WH_CSZ}	Pulse duration: CS high	10		ns
t _{WL_CSZ}	Pulse duration: CS low	10		ns
SPI INTER	ACE TIMINGS	·		
f _{CLK}	Maximum SCLK frequency		60	MHz
t _{CLK}	Minimum SCLK time period	16.67		ns
t _{PH_CK}	SCLK high time	0.45	0.55	t _{CLK}
t _{PL_CK}	SCLK low time	0.45	0.55	t _{CLK}
t _{SU_CSCK}	Setup time: CS falling to the first SCLK capture edge	5		ns
t _{SU_CKDI}	Setup time: SDI data valid to the SCLK capture edge	1.2		ns
t _{HT_CKDI}	Hold time: SCLK capture edge to data valid on SDI	0.65		ns
t _{D_CKCS}	Delay time: last SCLK falling to CS rising	5		ns

7.7 Switching Characteristics

at AVDD = 5 V, DVDD = 1.65 V to 5.5 V, and maximum throughput (unless otherwise noted); minimum and maximum values at $T_A = -40$ °C to +125°C; typical values at $T_A = 25$ °C

	PARAMETER	Test Conditions	MIN	MAX	UNIT
CONVERSION	ON CYCLE			<u> </u>	
t _{CONV}	ADC conversion time			600	ns
t _{ACQ}	Acquisition time		400		ns
RESET and	ALERT				
t _{PU}	Power-up time for device	AVDD \geq 2.35 V, C _{DECAP} = 1 μ F		5	ms
t _{RST}	Delay time; RST bit = 1b to device reset complete ⁽¹⁾			5	ms
t _{ALERT_HI}	ALERT high period	ALERT_LOGIC[1:0] = 1x	85	105	ns
t _{ALERT_LO}	ALERT low period	ALERT_LOGIC[1:0] = 1x	85	105	ns
SPI INTERF	ACE TIMINGS				
t _{DEN_CSDO}	Delay time: CS falling to data enable			15	ns
t _{DZ_CSDO}	Delay time: CS rising to SDO going Hi-Z			15	ns
t _{D_CKDO}	Delay time: SCLK launch edge to (next) data valid on SDO			15	ns

(1) RST bit is automatically reset to 0b after t_{RST}.



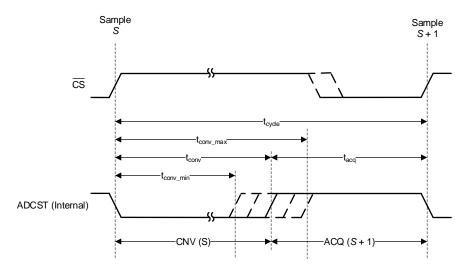
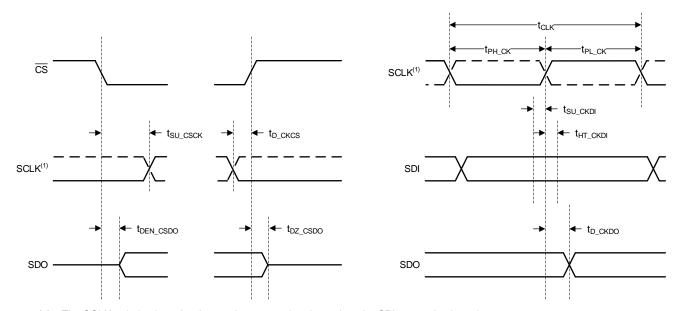


Figure 1. Conversion Cycle Timing



(1) The SCLK polarity, launch edge, and capture edge depend on the SPI protocol selected.

Figure 2. SPI-Compatible Serial Interface Timing

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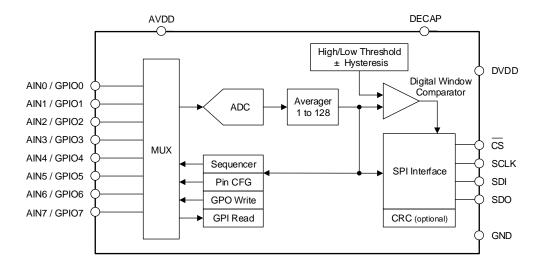
Detailed Description

Overview 8.1

The ADS7038 is a small, eight-channel, multiplexed, 12-bit, 1-MSPS, analog-to-digital converter (ADC) with an enhanced-SPI serial interface. The eight channels of the ADS7038 can be individually configured as either analog inputs, digital inputs, or digital outputs. The device includes a digital comparator which can be used to interrupt the host when a programmed high or low threshold is crossed on any input channel. The device uses an internal oscillator for conversion. The ADC can be used in manual mode for reading ADC data over the SPI interface or in autonomous mode for monitoring the analog inputs without an active SPI interface.

The device features a programmable averaging filter that outputs a 16-bit result for enhanced resolution.

8.2 Functional Block Diagram



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8.3 Feature Description

8.3.1 Multiplexer and ADC

The eight channels of the multiplexer can be independently configured as ADC inputs or general-purpose inputs/outputs (GPIOs). Figure 3 shows that each input pin has ESD protection diodes to AVDD and GND. On power-up or after device reset, all eight multiplexer channels are configured as analog inputs.

Figure 3 shows an equivalent circuit for pins configured as analog inputs. The ADC sampling switch is represented by ideal switch (SW) in series with the resistor R_{SW} (typically 150 Ω) and the sampling capacitor, C_{SH} (typically 12 pF).

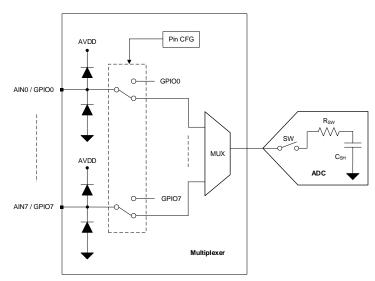


Figure 3. Analog Inputs, GPIOs, and ADC Connections

During acquisition, the SW switch is closed to allow the signal on the selected analog input channel to charge the internal sampling capacitor. During conversion, the SW switch is opened to disconnect the analog input channel from the sampling capacitor.

The multiplexer channels can be configured as GPIOs in the PIN_CFG register. The direction of a GPIO (either as an input or an output) can be set in the GPIO_CFG register. The logic level on the channels configured as digital inputs can be read from the GPI_VALUE register. The digital outputs can be accessed by writing to the GPO_OUTPUT_VALUE register. The digital outputs can be configured as either open-drain or push-pull in the GPO_DRIVE_CFG register.

8.3.2 Reference

The device uses the analog supply voltage (AVDD) as a reference for the analog-to-digital conversion process. TI recommends connecting a 1- μ F, low-equivalent series resistance (ESR) ceramic decoupling capacitor between the AVDD and GND pins.

8.3.3 ADC Transfer Function

The ADC output is in straight binary format. Equation 1 computes the ADC resolution:

$$1 LSB = V_{RFF} / 2^{N}$$

where:

V_{REF} = AVDD



Feature Description (continued)

Figure 4 and Table 1 detail the transfer characteristics for the device.

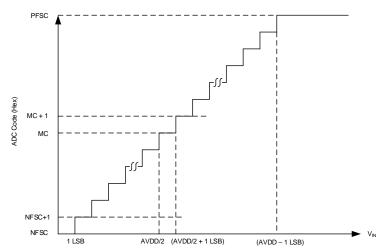


Figure 4. Ideal Transfer Characteristics

Table 1. Transfer Characteristics

INPUT VOLTAGE FOR SINGLE-ENDED INPUT	CODE	DESCRIPTION	IDEAL OUTPUT CODE
≤1 LSB	NFSC	Negative full-scale code	000
1 LSB to 2 LSBs	NFSC + 1	_	001
(AVDD / 2) to (AVDD / 2) + 1 LSB	MC	Mid code	800
(AVDD / 2) + 1 LSB to (AVDD / 2) + 2 LSB	MC + 1	_	801
≥ AVDD – 1 LSB	PFSC	Positive full-scale code	FFF

8.3.4 ADC Offset Calibration

The variation in ADC offset error resulting from changes in temperature or AVDD can be calibrated by setting the CAL bit in the GENERAL_CFG register. The CAL bit is reset to 0 after calibration. The host can poll the CAL bit to check the ADC offset calibration completion status.



8.3.5 Programmable Averaging Filter

The ADS7038 features a built-in oversampling (OSR) function that can be used to average several samples. The averaging filter can be enabled by programming the OSR[2:0] bits in the OSR_CFG register. The averaging filter configuration is common to all analog input channels. Figure 5 shows that the averaging filter module output is 16 bits long. In manual conversion mode and auto-sequence mode, only the first conversion for the selected analog input channel must be initiated by the host; see the *Manual Mode* and *Auto-Sequence Mode* sections. As shown in Figure 5, any remaining conversions for the selected averaging factor are generated internally. The time required to complete the averaging operation is determined by the sampling speed and number of samples to be averaged. As shown in Figure 5, the 16-bit result can be read out after the averaging operation completes.

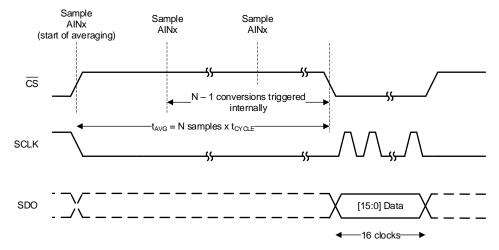


Figure 5. Averaging Example

In autonomous mode of operation, samples from analog input channels that are enabled in the AUTO_SEQ_CH_SEL register are averaged sequentially. The digital window comparator compares the top 12 bits of the 16-bit average result with the thresholds.

Equation 2 provides the LSB value of the 16-bit average result.

$$1 LSB = \frac{AVDD}{2^{16}} \tag{2}$$

8.3.6 CRC on Data Interface

The ADS7038 features a cyclic redundancy check (CRC) module for checking the integrity of the data bits exchanged over the SPI interface. The CRC module is bidirectional, which appends an 8-bit CRC to every byte read from the device and also evaluates the CRC of every incoming byte over the SPI interface. The CRC module uses the CRC-8-CCITT polynomial ($x^8 + x^2 + x + 1$) for CRC computation.

To enable the CRC module, set the CRC_EN bit in the GENERAL_CFG register. Table 2 shows the different ways that a CRC error that occurs when configuring the ADS7038 can be detected.

Table 2. Configuring Notifications when CRC Error is Detected

CRC ERROR NOTIFICATION	CONFIGURATION	DESCRIPTION
ALERT	ALERT_CRCIN = 1b	ALERT (internal signal) is asserted if a CRC error is detected
Status flags	APPEND_STATUS = 10b	4-bit status flags are appended to the ADC data. See the <i>Output Data Format</i> section for details.
Register read		Read the CRCERR_IN bit to check if a CRC error was detected.



When the ADS7038 detects a CRC error on the SPI interface, the erroneous data are ignored and the CRCERR_IN bit is set. Additional notifications can be enabled as described in Table 2. Further register writes are disabled until the CRCERR_IN bit is cleared by writing 1b to this bit. When using autonomous conversion mode, further conversions can be disabled on a CRC error on the SPI interface by setting CONV_ON_ERR = 1b.

8.3.7 General-Purpose I/Os

The eight channels of the ADS7038 can be independently configured as analog inputs, digital inputs, or digital outputs. Table 3 shows how the PIN_CFG and GPIO_CFG registers can be used to configure the device channels.

Table 3. Configuring Channels as Analog Inputs or GPIOs

PIN_CFG[7:0]	GPIO_CFG[7:0]	GPO_DRIVE_CFG[7:0]	CHANNEL CONFIGURATION
0	х	x	Analog input (default)
1	0	х	Digital input
1	1	0	Digital output; open-drain driver
1	1	1	Digital output; push-pull driver

Digital outputs can be configured to logic 1 or 0 by writing to the GPO_OUTPUT_VALUE register. Reading the GPI_VALUE register returns the logic level for all channels configured as digital inputs or digital outputs. The GPI_VALUE register can be read to detect a failure in external components, such as a floating pullup resistor or a low-impedance pulldown resistor, that prevents digital outputs being set to the desired logic level.

8.3.8 Oscillator and Timing Control

The device uses an internal oscillator for conversion. When using the averaging module, the host initiates the first conversion and subsequent conversions are generated internally by the device. Table 4 describes how the sampling rate can be controlled by the OSC_SEL and CLK_DIV[3:0] register fields when the device generates the start of the conversion.

Table 4. Configuring Sampling Rate for Internal Conversion Start Control

	OSC_SEL = 0	OSC_SEL		. = 1	
CLK_DIV[3:0]	SAMPLING FREQUENCY, f _{CYCLE} (kSPS)	CYCLE TIME, t _{CYCLE} (µs)	SAMPLING FREQUENCY, f _{CYCLE} (kSPS)	CYCLE TIME, t _{CYCLE} (µs)	
0000b	1000	1	31.25	32	
0001b	666.7	1.5	20.83	48	
0010b	500	2	15.63	64	
0011b	333.3	3	10.42	96	
0100b	250	4	7.81	128	
0101b	166.7	6	5.21	192	
0110b	125	8	3.91	256	
0111b	83	12	2.60	384	
1000b	62.5	16	1.95	512	
1001b	41.7	24	1.3	768	
1010b	31.3	32	0.98	1024	
1011b	20.8	48	0.65	1536	
1100b	15.6	64	0.49	2048	
1101b	10.4	96	0.33	3072	

The conversion time of the device, given by t_{CONV} in the *Switching Characteristics* table, is independent of the OSC_SEL and CLK_DIV[3:0] configuration.



8.3.9 Output Data Format

Figure 6 shows various SPI frames for reading data. The data output is MSB aligned. If averaging is enabled the output data from the ADC are 16 bits long, otherwise the output data are 12 bits long. Optionally, a 4-bit channel ID or status flags can be appended at the end of the output data by configuring the APPEND STATUS[1:0] field.

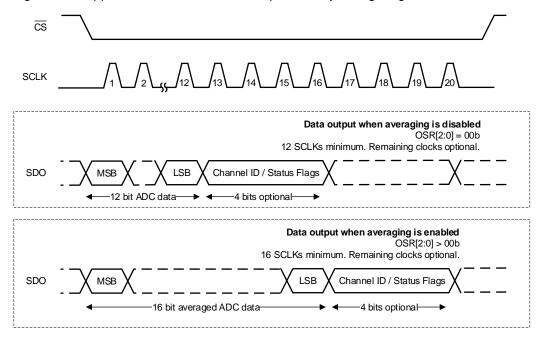


Figure 6. SPI Frames for Reading Data

8.3.10 Digital Window Comparator

The internal digital window comparator (DWC) is available in both conversion modes (manual and autonomous). The DWC outputs an internal ALERT signal. The internal ALERT signal can be output on any one of the digital output channels by configuring the ALERT_PIN register. Figure 7 provides a block diagram for the digital window comparator.

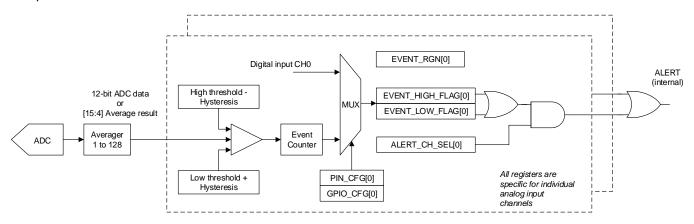


Figure 7. Digital Window Comparator Block Diagram

The low-side threshold, high-side threshold, event counter, and hysteresis parameters are independently programmable for each input channel. Figure 8 illustrates that the window comparator can monitor events for every analog input channel.



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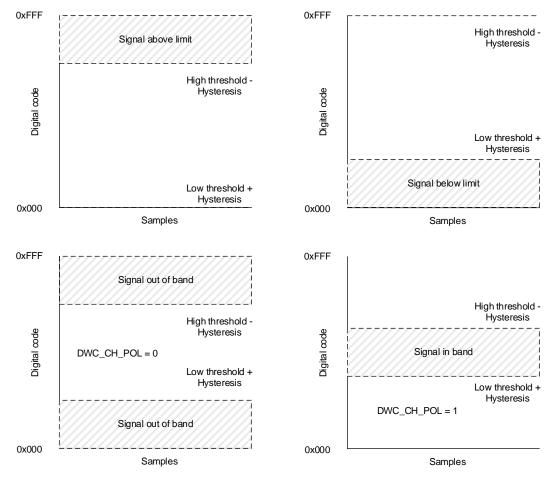


Figure 8. Event Monitoring With the Window Comparator

To enable the digital window comparator, set the DWC_EN bit in the GENERAL_CFG register. By default, hysteresis = 0, high threshold = 0xFFF, and low threshold = 0x000. For detecting when a signal is in-band, the EVENT_RGN register must be configured. In each of the cases shown in Figure 8, either or both ALERT_HIGH_FLAG and ALERT_LOW_FLAG can be set. The programmable event counter counts consecutive threshold violations before alert flags are set. The event count can be set to a higher value to avoid transients in the input signal setting the alert flags.

In order to assert the ALERT signal (internal) when the alert flag is set for a particular analog input channel, set the corresponding bit in the DWC_CH_SEL register. Alert flags are set, irrespective of the DWC_CH_SEL configuration, if DWC_EN = 1 and high or low thresholds are exceeded.

8.3.10.1 Interrupts From Digital Inputs

Table 5 shows that rising edge or falling edge events can be detected on channels configured as digital inputs.

Table 5. Configuring Interrupts From Digital Inputs

PIN_CFG[7:0]	GPIO_CFG[7:0]	EVENT_RGN[7:0]	EVENT DESCRIPTION
1	0	0	ALERT_HIGH_FLAG is set on the rising edge on the digital input channel
1	0	1	ALERT_LOW_FLAG is set on the falling edge on the digital input channel



8.3.10.2 Triggering Digital Outputs With Alert

Figure 9 shows that digital outputs can be updated in response to alerts from individual channels.

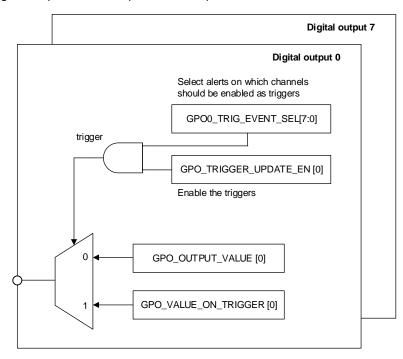


Figure 9. Block Diagram of the Digital Output Logic

8.3.10.2.1 Triggering Digital Outputs on Alerts

Any given digital output can be updated in response to an alert condition on one or more analog inputs and digital inputs. To update the digital output in response to alert conditions, configure the trigger and the value to be launched when the trigger occurs.

8.3.10.2.1.1 Trigger

The following events can act as triggers for updating the value on the digital output:

- An alert on one or more analog input channels. The digital window comparator must be enabled for these channels.
- An alert on one or more digital input channels. The digital window comparator must be enabled for these channels.

Configure the GPOx_TRIG_EVENT_SEL register to select which channels, analog inputs, or digital inputs can trigger an update on the digital output pin. After configuring the triggers for updating a digital output, the logic can be enabled by configuring the corresponding bit in the GPO TRIGGER UPDATE EN register.

8.3.10.2.1.2 Output Value

The digital outputs can be set to logic 1 or logic 0 in response to triggers. The value to be updated on the digital output when a trigger event occurs can be configured in the GPO_VALUE_ON_TRIGGER register.

8.3.11 Minimum, Maximum, and Latest Data Registers

The ADS7038 can record the minimum, maximum, and latest code (statistics registers) for every analog input channel. To enable or re-enable recording statistics, set the STATS_EN bit in the GENERAL_CFG register. Writing 1 to the STATS_EN bit reinitializes the statistics module. Afterwards, results from new conversions are recorded in the statistics registers. Previous values can be read from the statistics registers until a new conversion result is available. Before reading the statistics registers, set STATS_EN = 0 to prevent any updates to this block of registers.

8.3.12 Device Programming

NSTRUMENTS

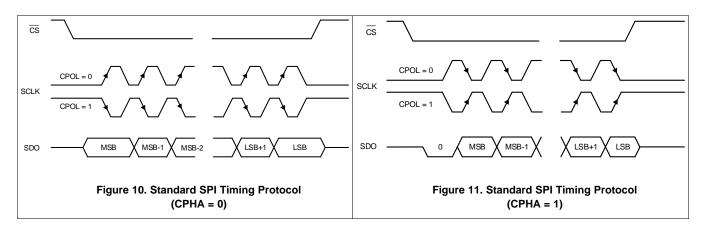
8.3.12.1 Enhanced-SPI Interface

The device features an enhanced-SPI interface that allows the host controller to operate at slower SCLK speeds and still achieve full throughput. As described in Table 6, the host controller can use any of the four SPIcompatible protocols (SPI-00, SPI-01, SPI-10, or SPI-11) to access the device.

Table 6. SPI Protocols for Configuring the Device

PROTOCOL	SCLK POLARITY (At the CS Falling Edge)	SCLK PHASE (Capture Edge)	CPOL_CPHA[1:0]	DIAGRAM
SPI-00	Low	Rising	00b	Figure 10
SPI-01	Low	Falling	01b	Figure 11
SPI-10	High	Falling	10b	Figure 10
SPI-11	High	Rising	11b	Figure 11

On power-up or after coming out of any asynchronous reset, the device supports the SPI-00 protocol for data read and data write operations. To select a different SPI-compatible protocol, program the CPOL CPHA[1:0] field. This first write operation must adhere to the SPI-00 protocol. Any subsequent data transfer frames must adhere to the newly-selected protocol.



8.3.12.2 Register Read/Write Operation

The device supports the commands listed in Table 7 to access the internal configuration registers.

Table 7. Opcodes for Commands

OPCODE	COMMAND DESCRIPTION
0000 0000b	No operation
0001 0000b	Single register read
0000 1000b	Single register write
0001 1000b	Set bit
0010 0000b	Clear bit

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8.3.12.2.1 Register Write

A 24-bit SPI frame is required for writing data to configuration registers. The 24-bit data on SDI, as shown in Figure 12. consists of an 8-bit write command (0000 1000b), an 8-bit register address, and 8-bit data. The write command is decoded on the $\overline{\text{CS}}$ rising edge and the specified register is updated with the 8-bit data specified during the register write operation.

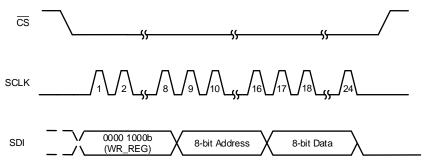


Figure 12. Register Write Operation

8.3.12.2.2 Register Read

Register read operation consists of two SPI frames: the first SPI frame initiates a register read and the second SPI frame reads data from the register address provided in the first frame. As shown in Figure 13, the 8-bit register address and the 8-bit dummy data are sent over the SDI pin during the first 24-bit frame with the read command (0001 0000b). On the rising edge of \overline{CS} , the read command is decoded and the requested register data are available for reading during the next frame. During the second frame, the first eight bits on SDO correspond to the requested register read. During the second frame, SDI can be used to initiate another operation or can be set to 0.

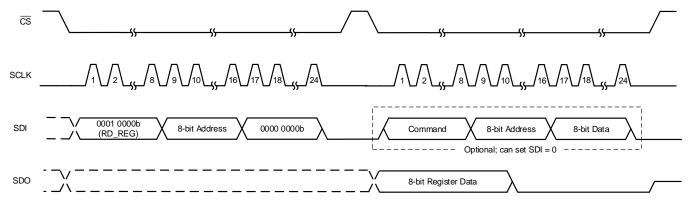


Figure 13. Register Read Operation

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8.4 Device Functional Modes

Table 8 lists the functional modes supported by the ADS7038.

Table 8. Functional Modes

FUNCTIONAL MODE	CONVERSION CONTROL	MUX CONTROL	CONV_MODE[1:0]	SEQ_MODE[1:0]
Manual	CS rising edge	Register write to MANUAL_CHID	00b	00b
On-the-fly	CS rising edge	First 5 bits after the CS falling edge	00b	10b
Auto-sequence	CS rising edge	Channel sequencer	00b	01b
Autonomous	Internal to the device	Channel sequencer	01b	01b

The device powers up in manual mode and can be configured into either of these modes by writing the configuration registers for the desired mode.

8.4.1 Device Power-Up and Reset

On power-up, the BOR bit is set indicating a power-cycle or reset event. The device can be reset by setting the RST bit or by recycling the power on the AVDD pin.

8.4.2 Manual Mode

Manual mode allows the external host processor to directly select the analog input channel. Figure 14 shows the steps for operating the device in manual mode.

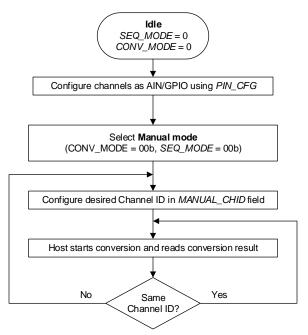


Figure 14. Device Operation in Manual Mode

In manual mode, the command to switch to a new channel (indicated by cycle N in Figure 15) is decoded by the device on the \overline{CS} rising edge. The \overline{CS} rising edge is also the start of the conversion signal, and therefore the device samples the previously selected MUX channel in cycle N+1. The newly selected analog input channel data are available in cycle N+2. For switching the analog input channel, a register write to the MANUAL_CHID field requires 24 clocks; see the *Register Write* section for more details. After a channel is selected, the number of clocks required for reading the output data depends on the device output data frame size; see the *Output Data Format* section for more details.



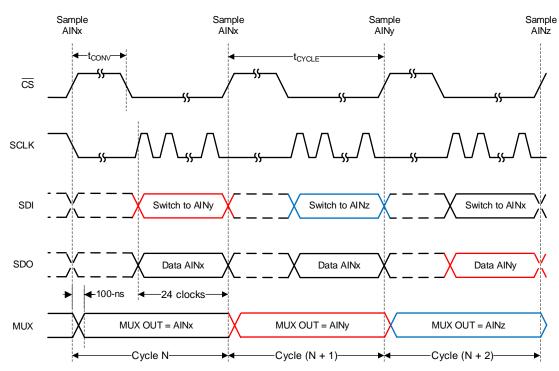


Figure 15. Starting Conversions and Reading Data in Manual Mode

8.4.3 On-the-Fly Mode

In the on-the-fly mode of operation, the <u>analog</u> input channel is selected, as shown in <u>Figure 16</u>, using the first five <u>bits</u> on SDI without waiting for the <u>CS</u> rising edge. Thus, the ADC samples the newly selected channel on the <u>CS</u> edge and there is no latency between the channel selection and the ADC output data.

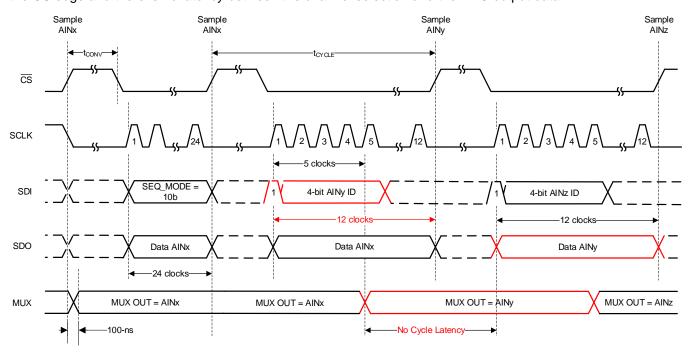


Figure 16. Starting Conversions and Reading Data in On-the-Fly Mode

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The number of clocks required for reading the output data depends on the device output data frame size; see the *Output Data Format* section for more details.

8.4.4 Auto-Sequence Mode

In auto-sequence mode, the internal channel sequencer switches the multiplexer to the next analog input channel after every conversion. The desired analog input channels can be configured for sequencing in the AUTO_SEQ_CHSEL register. To enable the channel sequencer, set SEQ_START = 1b. After every conversion, the channel sequencer switches the multiplexer to the next analog input in ascending order. To stop the channel sequencer from selecting channels, set SEQ_START = 0b.

In the example shown in Figure 17, AIN2 and AIN6 are enabled for sequencing in AUTO_SEQ_CHSEL. The channel sequencer loops through AIN2 and AIN6 and repeats until SEQ_START is set to 0b. The number of clocks required for reading the output data depends on the device output data frame size; see the *Output Data Format* section for more details.

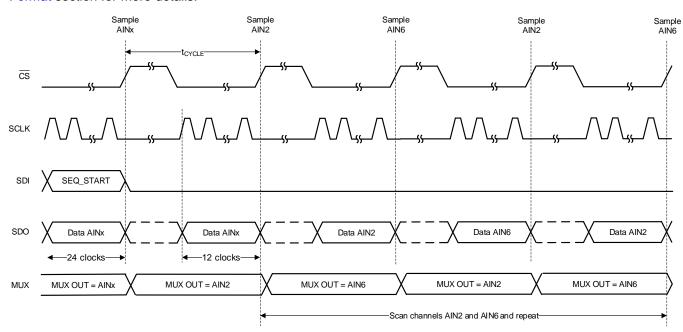


Figure 17. Starting Conversions and Reading Data in Auto-Sequence Mode

8.4.5 Autonomous Mode

In autonomous mode, the device can be programmed to monitor the voltage applied on the analog input pins of the device and generate an ALERT signal internal to the device when the programmable high or low threshold values are crossed. The internal ALERT signal can be mapped to any one digital output channel by configuring the channel ID in the ALERT_PIN[3:0] register field. In autonomous mode, the device generates the start of conversion using the internal oscillator. The first start of conversion must be provided by the host and the device generates the subsequent start of conversions.

Figure 18 shows the steps for configuring the functional mode to autonomous mode. Abort the on-going sequence by setting the SEQ_START to 0b before changing the functional mode or configuration of device.

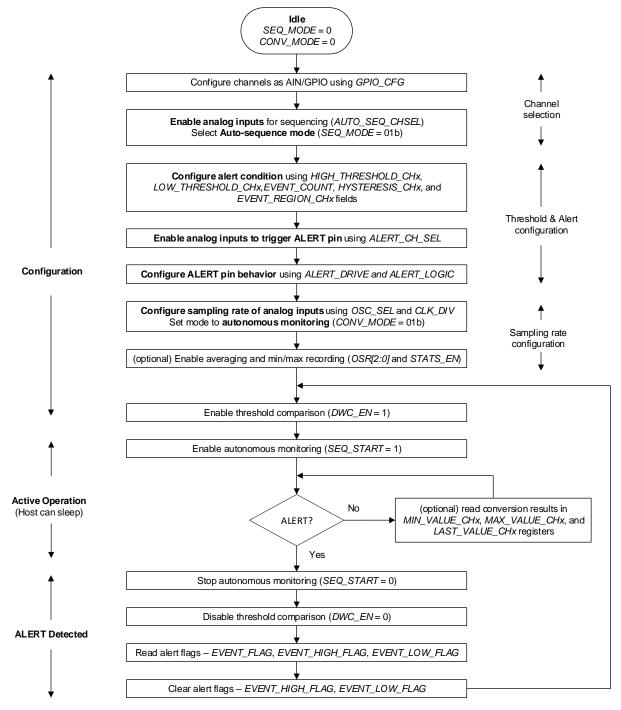


Figure 18. Configuring the Device in Autonomous Mode

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8.5 ADS7038 Registers

Table 9 lists the ADS7038 registers. All register offset addresses not listed in Table 9 should be considered as reserved locations and the register contents should not be modified.

Table 9. ADS7038 Registers

		Table 9. ADS7036 Registers
Address	Acronym	Register Section Name
0x0	SYSTEM_STATUS	SYSTEM_STATUS Register (Address = 0x0) [reset = 0x81]
0x1	GENERAL_CFG	GENERAL_CFG Register (Address = 0x1) [reset = 0x0]
0x2	DATA_CFG	DATA_CFG Register (Address = 0x2) [reset = 0x0]
0x3	OSR_CFG	OSR_CFG Register (Address = 0x3) [reset = 0x0]
0x4	OPMODE_CFG	OPMODE_CFG Register (Address = 0x4) [reset = 0x0]
0x5	PIN_CFG_LSB	PIN_CFG_LSB Register (Address = 0x5) [reset = 0x0]
0x7	GPIO_CFG_LSB	GPIO_CFG_LSB Register (Address = 0x7) [reset = 0x0]
0x9	GPO_DRIVE_CFG_LSB	GPO_DRIVE_CFG_LSB Register (Address = 0x9) [reset = 0x0]
0xB	GPO_OUTPUT_VALUE_LSB	GPO_OUTPUT_VALUE_LSB Register (Address = 0xB) [reset = 0x0]
0xD	GPI_VALUE_LSB	GPI_VALUE_LSB Register (Address = 0xD) [reset = 0x0]
0x10	SEQUENCE_CFG	SEQUENCE_CFG Register (Address = 0x10) [reset = 0x0]
0x11	CHANNEL_SEL	CHANNEL_SEL Register (Address = 0x11) [reset = 0x0]
0x12	AUTO_SEQ_CHSEL_LSB	AUTO_SEQ_CHSEL_LSB Register (Address = 0x12) [reset = 0x0]
0x14	ALERT_CH_SEL_LSB	ALERT_CH_SEL_LSB Register (Address = 0x14) [reset = 0x0]
0x16	ALERT_MAP	ALERT_MAP Register (Address = 0x16) [reset = 0x0]
0x17	ALERT_PIN_CFG	ALERT_PIN_CFG Register (Address = 0x17) [reset = 0x0]
0x18	EVENT_FLAG_LSB	EVENT_FLAG_LSB Register (Address = 0x18) [reset = 0x0]
0x1A	EVENT_HIGH_FLAG_LSB	EVENT_HIGH_FLAG_LSB Register (Address = 0x1A) [reset = 0x0]
0x1C	EVENT_LOW_FLAG_LSB	EVENT_LOW_FLAG_LSB Register (Address = 0x1C) [reset = 0x0]
0x1E	EVENT_RGN_LSB	EVENT_RGN_LSB Register (Address = 0x1E) [reset = 0x0]
0x20	HYSTERESIS_CH0	HYSTERESIS_CH0 Register (Address = 0x20) [reset = 0xF0]
0x21	HIGH_TH_CH0	HIGH_TH_CH0 Register (Address = 0x21) [reset = 0xFF]
0x22	EVENT_COUNT_CH0	EVENT_COUNT_CH0 Register (Address = 0x22) [reset = 0x0]
0x23	LOW_TH_CH0	LOW_TH_CH0 Register (Address = 0x23) [reset = 0x0]
0x24	HYSTERESIS_CH1	HYSTERESIS_CH1 Register (Address = 0x24) [reset = 0xF0]
0x25	HIGH_TH_CH1	HIGH_TH_CH1 Register (Address = 0x25) [reset = 0xFF]
0x26	EVENT_COUNT_CH1	EVENT_COUNT_CH1 Register (Address = 0x26) [reset = 0x0]
0x27	LOW_TH_CH1	LOW_TH_CH1 Register (Address = 0x27) [reset = 0x0]
0x28	HYSTERESIS_CH2	HYSTERESIS_CH2 Register (Address = 0x28) [reset = 0xF0]
0x29	HIGH_TH_CH2	HIGH_TH_CH2 Register (Address = 0x29) [reset = 0xFF]
0x2A	EVENT_COUNT_CH2	EVENT_COUNT_CH2 Register (Address = 0x2A) [reset = 0x0]
0x2B	LOW_TH_CH2	LOW_TH_CH2 Register (Address = 0x2B) [reset = 0x0]
0x2C	HYSTERESIS_CH3	HYSTERESIS_CH3 Register (Address = 0x2C) [reset = 0xF0]
0x2D	HIGH_TH_CH3	HIGH_TH_CH3 Register (Address = 0x2D) [reset = 0xFF]
0x2E	EVENT_COUNT_CH3	EVENT_COUNT_CH3 Register (Address = 0x2E) [reset = 0x0]
0x2F	LOW_TH_CH3	LOW_TH_CH3 Register (Address = 0x2F) [reset = 0x0]
0x30	HYSTERESIS_CH4	HYSTERESIS_CH4 Register (Address = 0x30) [reset = 0xF0]
0x31	HIGH_TH_CH4	HIGH_TH_CH4 Register (Address = 0x31) [reset = 0xFF]
0x32	EVENT_COUNT_CH4	EVENT_COUNT_CH4 Register (Address = 0x32) [reset = 0x0]
0x33	LOW_TH_CH4	LOW_TH_CH4 Register (Address = 0x33) [reset = 0x0]
0x34	HYSTERESIS_CH5	HYSTERESIS_CH5 Register (Address = 0x34) [reset = 0xF0]
0x35	HIGH_TH_CH5	HIGH_TH_CH5 Register (Address = 0x35) [reset = 0xFF]
0x36	EVENT_COUNT_CH5	EVENT_COUNT_CH5 Register (Address = 0x36) [reset = 0x0]



Table 9. ADS7038 Registers (continued)

		Table 9. AD57036 Registers (continued)
Address	Acronym	Register Section Name
0x37	LOW_TH_CH5	LOW_TH_CH5 Register (Address = 0x37) [reset = 0x0]
0x38	HYSTERESIS_CH6	HYSTERESIS_CH6 Register (Address = 0x38) [reset = 0xF0]
0x39	HIGH_TH_CH6	HIGH_TH_CH6 Register (Address = 0x39) [reset = 0xFF]
0x3A	EVENT_COUNT_CH6	EVENT_COUNT_CH6 Register (Address = 0x3A) [reset = 0x0]
0x3B	LOW_TH_CH6	LOW_TH_CH6 Register (Address = 0x3B) [reset = 0x0]
0x3C	HYSTERESIS_CH7	HYSTERESIS_CH7 Register (Address = 0x3C) [reset = 0xF0]
0x3D	HIGH_TH_CH7	HIGH_TH_CH7 Register (Address = 0x3D) [reset = 0xFF]
0x3E	EVENT_COUNT_CH7	EVENT_COUNT_CH7 Register (Address = 0x3E) [reset = 0x0]
0x3F	LOW_TH_CH7	LOW_TH_CH7 Register (Address = 0x3F) [reset = 0x0]
0x4E	RESERVED	RESERVED Register (Address = 0x4E) [reset = 0x0]
0x60	MAX_CH0_LSB	MAX_CH0_LSB Register (Address = 0x60) [reset = 0x0]
0x61	MAX_CH0_MSB	MAX_CH0_MSB Register (Address = 0x61) [reset = 0x0]
0x62	MAX_CH1_LSB	MAX_CH1_LSB Register (Address = 0x62) [reset = 0x0]
0x63	MAX_CH1_MSB	MAX_CH1_MSB Register (Address = 0x63) [reset = 0x0]
0x64	MAX_CH2_LSB	MAX_CH2_LSB Register (Address = 0x64) [reset = 0x0]
0x65	MAX_CH2_MSB	MAX_CH2_MSB Register (Address = 0x65) [reset = 0x0]
0x66	MAX_CH3_LSB	MAX_CH3_LSB Register (Address = 0x66) [reset = 0x0]
0x67	MAX_CH3_MSB	MAX_CH3_MSB Register (Address = 0x67) [reset = 0x0]
0x68	MAX_CH4_LSB	MAX_CH4_LSB Register (Address = 0x68) [reset = 0x0]
0x69	MAX_CH4_MSB	MAX_CH4_MSB Register (Address = 0x69) [reset = 0x0]
0x6A	MAX_CH5_LSB	MAX_CH5_LSB Register (Address = 0x6A) [reset = 0x0]
0x6B	MAX_CH5_MSB	MAX_CH5_MSB Register (Address = 0x6B) [reset = 0x0]
0x6C	MAX_CH6_LSB	MAX_CH6_LSB Register (Address = 0x6C) [reset = 0x0]
0x6D	MAX_CH6_MSB	MAX_CH6_MSB Register (Address = 0x6D) [reset = 0x0]
0x6E	MAX_CH7_LSB	MAX_CH7_LSB Register (Address = 0x6E) [reset = 0x0]
0x6F	MAX_CH7_MSB	MAX_CH7_MSB Register (Address = 0x6F) [reset = 0x0]
0x80	MIN_CH0_LSB	MIN_CH0_LSB Register (Address = 0x80) [reset = 0xFF]
0x81	MIN_CH0_MSB	MIN_CH0_MSB Register (Address = 0x81) [reset = 0xFF]
0x82	MIN_CH1_LSB	MIN_CH1_LSB Register (Address = 0x82) [reset = 0xFF]
0x83	MIN_CH1_MSB	MIN_CH1_MSB Register (Address = 0x83) [reset = 0xFF]
0x84	MIN_CH2_LSB	MIN_CH2_LSB Register (Address = 0x84) [reset = 0xFF]
0x85	MIN_CH2_MSB	MIN_CH2_MSB Register (Address = 0x85) [reset = 0xFF]
0x86	MIN_CH3_LSB	MIN_CH3_LSB Register (Address = 0x86) [reset = 0xFF]
0x87	MIN_CH3_MSB	MIN_CH3_MSB Register (Address = 0x87) [reset = 0xFF]
0x88	MIN_CH4_LSB	MIN_CH4_LSB Register (Address = 0x88) [reset = 0xFF]
0x89	MIN_CH4_MSB	MIN_CH4_MSB Register (Address = 0x89) [reset = 0xFF]
0x8A	MIN_CH5_LSB	MIN_CH5_LSB Register (Address = 0x8A) [reset = 0xFF]
0x8B	MIN_CH5_MSB	MIN_CH5_MSB Register (Address = 0x8B) [reset = 0xFF]
0x8C	MIN_CH6_LSB	MIN_CH6_LSB Register (Address = 0x8C) [reset = 0xFF]
0x8D	MIN_CH6_MSB	MIN_CH6_MSB Register (Address = 0x8D) [reset = 0xFF]
0x8E	MIN_CH7_LSB	MIN_CH7_LSB Register (Address = 0x8E) [reset = 0xFF]
0x8F	MIN_CH7_MSB	MIN_CH7_MSB Register (Address = 0x8F) [reset = 0xFF]
0xA0	RECENT_CH0_LSB	RECENT_CH0_LSB Register (Address = 0xA0) [reset = 0x0]
0xA1	RECENT_CH0_MSB	RECENT_CH0_MSB Register (Address = 0xA1) [reset = 0x0]
0xA2	RECENT_CH1_LSB	RECENT_CH1_LSB Register (Address = 0xA2) [reset = 0x0]
0xA3	RECENT_CH1_MSB	RECENT_CH1_MSB Register (Address = 0xA3) [reset = 0x0]
0xA4	RECENT_CH2_LSB	RECENT_CH2_LSB Register (Address = 0xA4) [reset = 0x0]

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Table 9. ADS7038 Registers (continued)

Address	Acronym	Register Name	Section
0xA5	RECENT_CH2_MSB		RECENT_CH2_MSB Register (Address = 0xA5) [reset = 0x0]
0xA6	RECENT_CH3_LSB		RECENT_CH3_LSB Register (Address = 0xA6) [reset = 0x0]
0xA7	RECENT_CH3_MSB		RECENT_CH3_MSB Register (Address = 0xA7) [reset = 0x0]
0xA8	RECENT_CH4_LSB		RECENT_CH4_LSB Register (Address = 0xA8) [reset = 0x0]
0xA9	RECENT_CH4_MSB		RECENT_CH4_MSB Register (Address = 0xA9) [reset = 0x0]
0xAA	RECENT_CH5_LSB		RECENT_CH5_LSB Register (Address = 0xAA) [reset = 0x0]
0xAB	RECENT_CH5_MSB		RECENT_CH5_MSB Register (Address = 0xAB) [reset = 0x0]
0xAC	RECENT_CH6_LSB		RECENT_CH6_LSB Register (Address = 0xAC) [reset = 0x0]
0xAD	RECENT_CH6_MSB		RECENT_CH6_MSB Register (Address = 0xAD) [reset = 0x0]
0xAE	RECENT_CH7_LSB		RECENT_CH7_LSB Register (Address = 0xAE) [reset = 0x0]
0xAF	RECENT_CH7_MSB		RECENT_CH7_MSB Register (Address = 0xAF) [reset = 0x0]
0xC3	GPO0_TRIG_EVENT_SEL		GPO0_TRIG_EVENT_SEL Register (Address = 0xC3) [reset = 0x0]
0xC5	GPO1_TRIG_EVENT_SEL		GPO1_TRIG_EVENT_SEL Register (Address = 0xC5) [reset = 0x0]
0xC7	GPO2_TRIG_EVENT_SEL		GPO2_TRIG_EVENT_SEL Register (Address = 0xC7) [reset = 0x0]
0xC9	GPO3_TRIG_EVENT_SEL		GPO3_TRIG_EVENT_SEL Register (Address = 0xC9) [reset = 0x0]
0xCB	GPO4_TRIG_EVENT_SEL		GPO4_TRIG_EVENT_SEL Register (Address = 0xCB) [reset = 0x0]
0xCD	GPO5_TRIG_EVENT_SEL		GPO5_TRIG_EVENT_SEL Register (Address = 0xCD) [reset = 0x0]
0xCF	GPO6_TRIG_EVENT_SEL		GPO6_TRIG_EVENT_SEL Register (Address = 0xCF) [reset = 0x0]
0xD1	GPO7_TRIG_EVENT_SEL		GPO7_TRIG_EVENT_SEL Register (Address = 0xD1) [reset = 0x0]
0xE9	GPO_TRIGGER_CFG		GPO_TRIGGER_CFG Register (Address = 0xE9) [reset = 0x0]
0xEB	GPO_VALUE_TRIG		GPO_VALUE_TRIG Register (Address = 0xEB) [reset = 0x0]

Complex bit access types are encoded to fit into small table cells. Table 10 shows the codes that are used for access types in this section.

Table 10. ADS7038 Access Type Codes

		Trouble Type Codes		
Access Type	Code	Description		
Read Type	Read Type			
R	R	Read		
Write Type				
W	W	Write		
Reset or Default	Value			
-n		Value after reset or the default value		
Register Array V	ariables			
i,j,k,l,m,n		When these variables are used in a register name, an offset, or an address, they refer to the value of a register array where the register is part of a group of repeating registers. The register groups form a hierarchical structure and the array is represented with a formula.		
У		When this variable is used in a register name, an offset, or an address it refers to the value of a register array.		

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8.5.1 SYSTEM_STATUS Register (Address = 0x0) [reset = 0x81]

SYSTEM_STATUS is shown in Figure 19 and described in Table 11.

Return to the Summary Table.

Figure 19. SYSTEM_STATUS Register

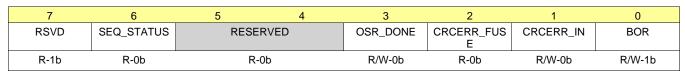


Table 11. SYSTEM_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description
7	RSVD	R	1b	Reads return 1b.
6	SEQ_STATUS	R	0b	Status of the channel sequencer.
				0b = Sequence stopped
				1b = Sequence in progress
5-4	RESERVED	R	0b	Reserved. Reads return 1b.
3	OSR_DONE	R/W	0b	Averaging status. Clear this bit by writing 1b to this bit.
				0b = Averaging in progress or not started; average result is not ready.
				1b = Averaging complete; average result is ready.
2	CRCERR_FUSE	R	0b	Device power-up configuration CRC check status. To re-evaluate this bit, software reset the device or power cycle AVDD.
				0b = No problems detected in power-up configuration.
				1b = Device configuration not loaded correctly.
1	CRCERR_IN	R/W	0b	Status of CRC check on incoming data. Write 1b to clear this error flag.
				0b = No CRC error.
				1b = CRC error detected. All register writes, except to addresses 0x00 and 0x01, are blocked.
0	BOR	R/W	1b	Brown out reset indicator. This bit is set if brown out condition occurs or device is power cycled. Write 1b to this bit to clear the flag.
				0b = No brown out from the last time this bit was cleared.
				1b = Brown out condition detected or device power cycled.

8.5.2 GENERAL_CFG Register (Address = 0x1) [reset = 0x0]

GENERAL_CFG is shown in Figure 20 and described in Table 12.

Return to the Summary Table.

Figure 20. GENERAL_CFG Register

7	6	5	4	3	2	1	0
RESERVED	CRC_EN	STATS_EN	DWC_EN	RESERVED	CH_RST	CAL	RST
R-0b	R/W-0b	R/W-0b	R/W-0b	R-0b	R/W-0b	R/W-0b	W-0b

Table 12. GENERAL_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7	RESERVED	R	0b	Reserved. Reads return 1b.
6	CRC_EN	R/W	0b	Enable or disable the CRC on device interface.
				0b = CRC module disabled.
				1b = CRC appended to data output. CRC check is enabled on incoming data.



Table 12. GENERAL_CFG Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
5	STATS_EN	R/W	0b	Enable or disable the statistics module.
				0b = Minimum, maximum, and recent value registers are not updated.
				1b = Clear minimum, maximum, and recent value registers and conitnue updating with new conversion results.
4	DWC_EN	R/W	0b	Enable or disable the digital window comparator.
				0b = Reset or disable the digital window comparator.
				1b = Enable digital window comparator.
3	RESERVED	R	0b	Reserved. Reads return 0b.
2	CH_RST	R/W	0b	Force all channels to be analog inputs.
				0b = Normal operation.
				1b = All channels will be set as analog inputs irrespective of configuration in other registers.
1	CAL	R/W	0b	Calibrate ADC offset.
				0b = Normal operation.
				1b = ADC offset is calibrated. After calibration is complete, this bit is set to 0b.
0	RST	W	0b	Software reset all registers to default values.
				0b = Normal operation.
				1b = Device is reset. After reset is complete, this bit is set to 0b and BOR bit is set to 1b.

8.5.3 DATA_CFG Register (Address = 0x2) [reset = 0x0]

DATA_CFG is shown in Figure 21 and described in Table 13.

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Figure 21. DATA_CFG Register

7	6	5	4	3	2	1	0
FIX_PAT	RESERVED	APPEND_ST	ATUS[1:0]	RESEI	RVED	CPOL_C	PHA[1:0]
R/W-0b	R-0b	R/W-0b		R-0	0b	R/W	/-0b

Table 13. DATA_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7	FIX_PAT	R/W	0b	Device outputs fixed data bits which can be helpful for debugging communication with the device.
				0b = Normal operation.
				1b = Device outputs fixed code 0xA5A repeatitively when reading ADC data.
6	RESERVED	R	0b	Reserved. Reads return 0b.
5-4	APPEND_STATUS[1:0]	R/W	0b	Append 4-bit channel ID or status flags to output data. 00b: 01b: 10b: 11b:
				0b = Channel ID and status flags are not appended to ADC data.
				1b = 4-bit channel ID is appended to ADC data.
				10b = 4-bit status flags are appended to ADC data.
				11b = Reserved.
3-2	RESERVED	R	0b	Reserved. Reads return 0b.
1-0	CPOL_CPHA[1:0]	R/W	0b	This field sets the polarity and phase of SPI communication.
				0b = CPOL = 0, $CPHA = 0$.
				1b = CPOL = 0, CPHA = 1.
				10b = CPOL = 1, $CPHA = 0$.
				11b = CPOL = 1, CPHA = 1.



8.5.4 OSR_CFG Register (Address = 0x3) [reset = 0x0]

OSR_CFG is shown in Figure 22 and described in Table 14.

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Figure 22. OSR_CFG Register

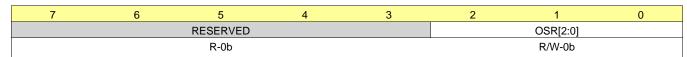


Table 14. OSR_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-3	RESERVED	R	0b	Reserved. Reads return 0b.
2-0	OSR[2:0]	R/W	0b	Selects the oversampling ratio for ADC conversion result.
				0b = No averaging
				1b = 2 samples
				10b = 4 samples
				11b = 8 samples
				100b = 16 samples
				101b = 32 samples
				110b = 64 samples
				111b = 128 samples

8.5.5 OPMODE_CFG Register (Address = 0x4) [reset = 0x0]

OPMODE_CFG is shown in Figure 23 and described in Table 15.

Return to the Summary Table.

Figure 23. OPMODE_CFG Register

7	6	5	4	3	2	1	0
CONV_ON_ER R	CONV_MODE[1:0]		OSC_SEL	CLK_DIV[3:0]			
R/W-0b R/W-0b		R/W-0b		R/W	/-0b		

Table 15. OPMODE_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7	CONV_ON_ERR	R/W	0b	Control continuation of autonomous modes if CRC error is detected on communication interface.
				0b = If CRC error is detected, device continues channel sequencing and pin configuration is retained. See the CRCERR_IN bit for more details.
				1b = If CRC error is detected, devicel changes all channels to analog inpts and channel sequencing is paused until CRCERR_IN = 1b. After clearing CRCERR_IN flag, device resumes channel sequencing and pin confguration is restored.
6-5	CONV_MODE[1:0]	R/W	0b	These bits set the mode of conversion of the ADC.
				0b = Manual mode; conversions are initiated by host.
				1b = Autonomous mode; conversions are initiated by the internal state machine.
4	OSC_SEL	R/W	0b	Selects the oscillator for internal timing generation.
				0b = High-speed oscillator.
				1b = Low-power oscillator.
3-0	CLK_DIV[3:0]	R/W	0b	Sampling speed control in autonomous monitoring mode (CONV_MODE = 01b). See the section on oscillator and timing control for details.



8.5.6 PIN_CFG_LSB Register (Address = 0x5) [reset = 0x0]

PIN_CFG_LSB is shown in Figure 24 and described in Table 16.

Return to the Summary Table.

Figure 24. PIN_CFG_LSB Register

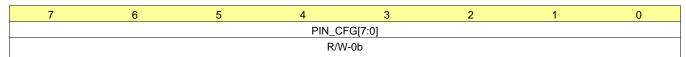


Table 16. PIN_CFG_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	PIN_CFG[7:0]	R/W	0b	Configure device channels AIN / GPIO [7:0] as analog inputs or GPIOs.
				0b = Channel is configured as analog input.
				1b = Channel is configured as GPIO.

8.5.7 GPIO_CFG_LSB Register (Address = 0x7) [reset = 0x0]

GPIO_CFG_LSB is shown in Figure 25 and described in Table 17.

Return to the Summary Table.

Figure 25. GPIO_CFG_LSB Register

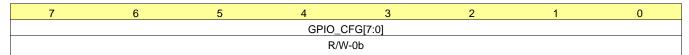


Table 17. GPIO CFG LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPIO_CFG[7:0]	R/W	0b	Configure GPIO[7:0] as either digital inputs or digital outputs.
				0b = GPIO is configured as digital input.
				1b = GPIO is configured as digital output.

8.5.8 GPO_DRIVE_CFG_LSB Register (Address = 0x9) [reset = 0x0]

GPO_DRIVE_CFG_LSB is shown in Figure 26 and described in Table 18.

Return to the Summary Table.

Figure 26. GPO DRIVE CFG LSB Register

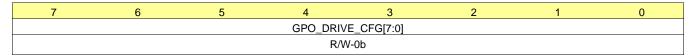


Table 18. GPO_DRIVE_CFG_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO_DRIVE_CFG[7:0]	R/W	0b	Configure digital outputs GPO[7:0] as open-drain or push-pull outputs.
				0b = Digital output is open-drain; connect external pullup resistor.
				1b = Push-pull driver is used for digital output.

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8.5.9 GPO_OUTPUT_VALUE_LSB Register (Address = 0xB) [reset = 0x0]

GPO_OUTPUT_VALUE_LSB is shown in Figure 27 and described in Table 19.

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Figure 27. GPO_OUTPUT_VALUE_LSB Register

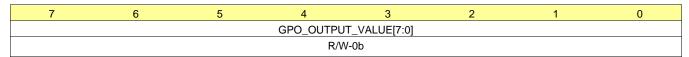


Table 19. GPO_OUTPUT_VALUE_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO_OUTPUT_VALUE[7:	R/W	0b	Logic level to be set on digital outputs GPO[7:0].
	0]			0b = Digital output set to logic 0.
				1b = Digital output set to logic 1.

8.5.10 GPI_VALUE_LSB Register (Address = 0xD) [reset = 0x0]

GPI_VALUE_LSB is shown in Figure 28 and described in Table 20.

Return to the Summary Table.

Figure 28. GPI_VALUE_LSB Register

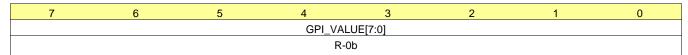


Table 20. GPI_VALUE_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPI_VALUE[7:0]	R	0b	Readback the logic level on GPIO[7:0].
				0b = GPIO is at logic 0.
				1b = GPIO is at logic 1.

8.5.11 SEQUENCE_CFG Register (Address = 0x10) [reset = 0x0]

SEQUENCE_CFG is shown in Figure 29 and described in Table 21.

Return to the Summary Table.

Figure 29. SEQUENCE_CFG Register

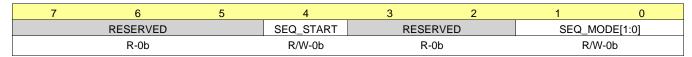


Table 21. SEQUENCE_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	RESERVED	R	0b	Reserved. Reads return 0b.
4	SEQ_START	R/W	0b	Control for start of channel sequence when using auto sequence mode (SEQ_MODE = 01b).
				0b = Stop channel sequencing.
				1b = Start channel sequencing in ascending order for channels enabled in AUTO_SEQ_CHSEL register.
3-2	RESERVED	R	0b	Reserved. Reads return 0b.



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Table 21. SEQUENCE_CFG Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
1-0	SEQ_MODE[1:0]	R/W	0b	Selects the mode of scanning of analog input channels.
				0b = Manual sequence mode; channel selected by MANUAL_CHID field.
				1b = Auto sequence mode; channel selected by AUTO_SEQ_CHSEL.
				10b = On-the-fly sequence mode.
				11b = Reserved.

8.5.12 CHANNEL_SEL Register (Address = 0x11) [reset = 0x0]

CHANNEL_SEL is shown in Figure 30 and described in Table 22. Return to the Summary Table.

Figure 30. CHANNEL_SEL Register

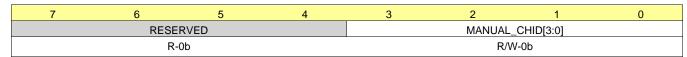


Table 22. CHANNEL_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	RESERVED	R	0b	Reserved. Reads return 0b.
3-0	MANUAL_CHID[3:0]	R/W	Ob	In manual mode (SEQ_MODE = 00b), this field contains the 4-bit channel ID of the analog input channel for next ADC conversion. For valid ADC data, the selected channel must not be configured as GPIO in PIN_CFG register. 1xxx = Reserved.
				0b = AIN0
				1b = AIN1
				10b = AIN2
				11b = AIN3
				100b = AIN4
				101b = AIN5
				110b = AIN6
				111b = AIN7

8.5.13 AUTO_SEQ_CHSEL_LSB Register (Address = 0x12) [reset = 0x0]

AUTO_SEQ_CHSEL_LSB is shown in Figure 31 and described in Table 23.

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Figure 31. AUTO_SEQ_CHSEL_LSB Register

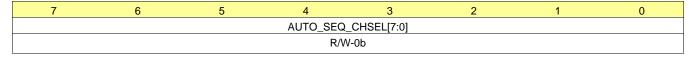


Table 23. AUTO_SEQ_CHSEL_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	AUTO_SEQ_CHSEL[7:0]	R/W	0b	Select analog input channels AIN[7:0] in for auto sequencing mode.
				0b = Analog input channel is not enabled in scanning sequence.
				1b = Analog input channel is enabled in scanning sequence.



8.5.14 ALERT_CH_SEL_LSB Register (Address = 0x14) [reset = 0x0]

ALERT_CH_SEL_LSB is shown in Figure 32 and described in Table 24.

Return to the Summary Table.

Figure 32. ALERT_CH_SEL_LSB Register

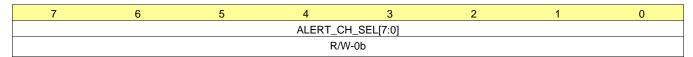


Table 24. ALERT_CH_SEL_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	ALERT_CH_SEL[7:0]	R/W	Ob	Select channels for which the alert flags can assert the internal ALERT signal. The ALERT signal can be mapped to the digital output channel configured in the ALERT_PIN[3:0] field.
				0b = Alert flags for this channel do not assert the ALERT pin.
				1b = Alert flags for this channel assert the ALERT pin.

8.5.15 ALERT_MAP Register (Address = 0x16) [reset = 0x0]

ALERT_MAP is shown in Figure 33 and described in Table 25.

Return to the Summary Table.

Figure 33. ALERT_MAP Register

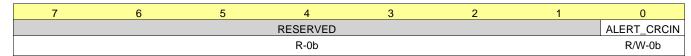


Table 25. ALERT_MAP Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	RESERVED	R	0b	Reserved. Reads return 0b.
0	ALERT_CRCIN	R/W	0b	Enable or disable the alert notification for CRC error on input data (CRCERR_IN = 1b).
				0b = ALERT signal is not asserted when CRCERR_IN = 1b.
				1b = ALERT signal is asserted when CRCERR_IN = 1b. Clear CRCERR_IN for deasserting the ALERT pin.

8.5.16 ALERT_PIN_CFG Register (Address = 0x17) [reset = 0x0]

ALERT_PIN_CFG is shown in Figure 34 and described in Table 26.

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Figure 34. ALERT_PIN_CFG Register

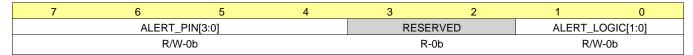


Table 26. ALERT_PIN_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	ALERT_PIN[3:0]	R/W	0b	Internal ALERT output of the digital window comparator will be output on this channel. This channel must be configured as digital output.
3-2	RESERVED	R	0b	Reserved. Reads return 0b.



Table 26. ALERT_PIN_CFG Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
1-0	ALERT_LOGIC[1:0]	R/W	0b	Configure how the ALERT signal is asserted.
				0b = Pulsed high (one logic high pulse once per alert flag).
				1b = Active high.

8.5.17 EVENT_FLAG_LSB Register (Address = 0x18) [reset = 0x0]

EVENT_FLAG_LSB is shown in Figure 35 and described in Table 27.

Return to the Summary Table.

Figure 35. EVENT_FLAG_LSB Register

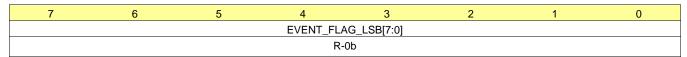


Table 27. EVENT_FLAG_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	EVENT_FLAG_LSB[7:0]	R	0b	Alert flags indicating digital window comparator status for CH[7:0]. Write 0b to individual bits of high/low register to clear alert flag.
				0b = Event condition not detected.
				1b = Event condition detected.

8.5.18 EVENT_HIGH_FLAG_LSB Register (Address = 0x1A) [reset = 0x0]

EVENT HIGH FLAG LSB is shown in Figure 36 and described in Table 28.

Return to the Summary Table.

Figure 36. EVENT_HIGH_FLAG_LSB Register

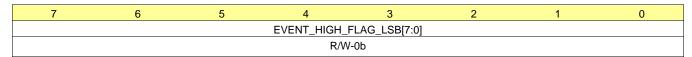


Table 28. EVENT_HIGH_FLAG_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	EVENT_HIGH_FLAG_LS B[7:0]	R/W	Ob	Alert flag corresponding to high threshold of analog input or rising edge of digital input on CH[7:0]. Write 1b to clear this flag. 0b = No alert condition detected. 1b = Either high threshold was exceeded (analog input) or rising edge was detected (digital input).

8.5.19 EVENT_LOW_FLAG_LSB Register (Address = 0x1C) [reset = 0x0]

EVENT_LOW_FLAG_LSB is shown in Figure 37 and described in Table 29.

Return to the Summary Table.

Figure 37. EVENT_LOW_FLAG_LSB Register

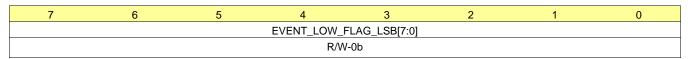




Table 29. EVENT_LOW_FLAG_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	EVENT_LOW_FLAG_LSB [7:0]	R/W	0b	Alert flag corresponding to low threshold of analog input or falling edge of digital input on CH[7:0]. Write 1b to clear this flag.
				0b = No Event condition detected.
				1b = Either low threshold was exceeded (analog input) or falling edge was detected (digital input).

8.5.20 EVENT_RGN_LSB Register (Address = 0x1E) [reset = 0x0]

EVENT_RGN_LSB is shown in Figure 38 and described in Table 30.

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Figure 38. EVENT_RGN_LSB Register

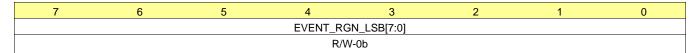


Table 30. EVENT_RGN_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	EVENT_RGN_LSB[7:0]	R/W	0b	Choice of region used in monitoring analog/digital inputs CH[7:0].
				Ob = Alert flag is set if: (conversion result < low threshold) or (conversion result > high threshold). For digital inputs, logic 1 sets the alert flag.
				1b = Alert flag is set if: (low threshold > conversion result < high threshold). For digital inputs, logic 0 sets the alert flag.

8.5.21 HYSTERESIS_CH0 Register (Address = 0x20) [reset = 0xF0]

HYSTERESIS_CH0 is shown in Figure 39 and described in Table 31.

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Figure 39. HYSTERESIS_CH0 Register

	7	6	5	4	3	2	1	0	
HIGH_THRESHOLD_CH0_LSB[3:0]					HYSTERESIS_CH0[3:0]				
	R/W-1111b					R/V	V-0b		

Table 31. HYSTERESIS_CH0 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH0 _LSB[3:0]	R/W	1111b	Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	HYSTERESIS_CH0[3:0]	R/W		4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.22 HIGH_TH_CH0 Register (Address = 0x21) [reset = 0xFF]

HIGH_TH_CH0 is shown in Figure 40 and described in Table 32.

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Figure 40. HIGH TH CH0 Register

7	6	5	4	3	2	1	0
			HIGH_THRESHOL	_D_CH0_MSB[7:0)]		
			R/W-11	111111b			



Table 32. HIGH_TH_CH0 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH0 _MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.23 EVENT COUNT CH0 Register (Address = 0x22) [reset = 0x0]

EVENT_COUNT_CH0 is shown in Figure 41 and described in Table 33.

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Figure 41. EVENT_COUNT_CH0 Register

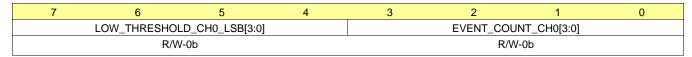


Table 33. EVENT_COUNT_CH0 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH0 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH0[3:0]	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.24 LOW_TH_CH0 Register (Address = 0x23) [reset = 0x0]

LOW_TH_CH0 is shown in Figure 42 and described in Table 34.

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Figure 42. LOW_TH_CH0 Register

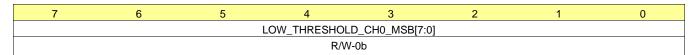


Table 34. LOW_TH_CH0 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH0	R/W	0b	MSB aligned high threshold for analog input. These bits are
	MSB[7:0]			compared with top 8 bits of ADC conversion result.

8.5.25 HYSTERESIS CH1 Register (Address = 0x24) [reset = 0xF0]

HYSTERESIS_CH1 is shown in Figure 43 and described in Table 35.

Return to the Summary Table.

Figure 43. HYSTERESIS_CH1 Register

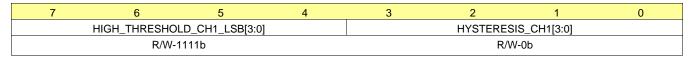


Table 35. HYSTERESIS_CH1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH1 _LSB[3:0]	R/W		Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.



Table 35. HYSTERESIS_CH1 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
3-0	HYSTERESIS_CH1[3:0]	R/W	0b	4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.26 HIGH_TH_CH1 Register (Address = 0x25) [reset = 0xFF]

HIGH_TH_CH1 is shown in Figure 44 and described in Table 36.

Return to the Summary Table.

Figure 44. HIGH_TH_CH1 Register



Table 36. HIGH_TH_CH1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH1 _MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.27 EVENT_COUNT_CH1 Register (Address = 0x26) [reset = 0x0]

EVENT_COUNT_CH1 is shown in Figure 45 and described in Table 37.

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Figure 45. EVENT_COUNT_CH1 Register

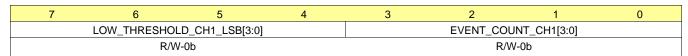


Table 37. EVENT_COUNT_CH1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH1 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH1[3:0	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.28 LOW_TH_CH1 Register (Address = 0x27) [reset = 0x0]

LOW_TH_CH1 is shown in Figure 46 and described in Table 38.

Return to the Summary Table.

Figure 46. LOW_TH_CH1 Register

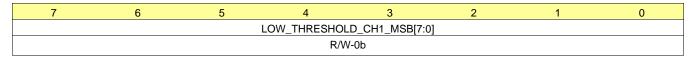


Table 38. LOW_TH_CH1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH1 _MSB[7:0]	R/W	0b	MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.



8.5.29 HYSTERESIS_CH2 Register (Address = 0x28) [reset = 0xF0]

HYSTERESIS_CH2 is shown in Figure 47 and described in Table 39.

Return to the Summary Table.

Figure 47. HYSTERESIS_CH2 Register

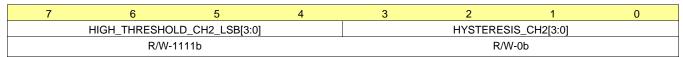


Table 39. HYSTERESIS CH2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH2 _LSB[3:0]	R/W	1111b	Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	HYSTERESIS_CH2[3:0]	R/W		4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.30 HIGH_TH_CH2 Register (Address = 0x29) [reset = 0xFF]

HIGH_TH_CH2 is shown in Figure 48 and described in Table 40.

Return to the Summary Table.

Figure 48. HIGH_TH_CH2 Register



Table 40. HIGH_TH_CH2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH2	R/W		MSB aligned high threshold for analog input. These bits are
	_MSB[7:0]			compared with top 8 bits of ADC conversion result.

8.5.31 EVENT COUNT CH2 Register (Address = 0x2A) [reset = 0x0]

EVENT_COUNT_CH2 is shown in Figure 49 and described in Table 41.

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Figure 49. EVENT_COUNT_CH2 Register

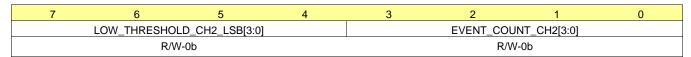


Table 41. EVENT_COUNT_CH2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH2 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH2[3:0]	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.32 LOW_TH_CH2 Register (Address = 0x2B) [reset = 0x0]

LOW_TH_CH2 is shown in Figure 50 and described in Table 42.

Return to the Summary Table.



Figure 50. LOW_TH_CH2 Register

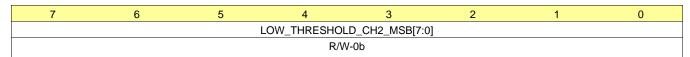


Table 42. LOW_TH_CH2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH2	R/W	0b	MSB aligned high threshold for analog input. These bits are
	_MSB[7:0]			compared with top 8 bits of ADC conversion result.

8.5.33 HYSTERESIS_CH3 Register (Address = 0x2C) [reset = 0xF0]

HYSTERESIS_CH3 is shown in Figure 51 and described in Table 43.

Return to the Summary Table.

Figure 51. HYSTERESIS_CH3 Register

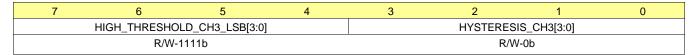


Table 43. HYSTERESIS_CH3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH3 _LSB[3:0]	R/W	1111b	Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	HYSTERESIS_CH3[3:0]	R/W		4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.34 HIGH_TH_CH3 Register (Address = 0x2D) [reset = 0xFF]

HIGH_TH_CH3 is shown in Figure 52 and described in Table 44.

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Figure 52. HIGH TH CH3 Register

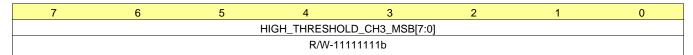


Table 44. HIGH_TH_CH3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH3 _MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.35 EVENT_COUNT_CH3 Register (Address = 0x2E) [reset = 0x0]

EVENT_COUNT_CH3 is shown in Figure 53 and described in Table 45.

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Figure 53. EVENT_COUNT_CH3 Register

7 6	5	4	3	2	1	0
LOW_THRESHOLI	D_CH3_LSB[3:0]		EVENT_COUNT_CH3[3:0]			
R/W-	0b			R/V	V-0b	



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Table 45. EVENT_COUNT_CH3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH3 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH3[3:0	R/W		Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.36 LOW_TH_CH3 Register (Address = 0x2F) [reset = 0x0]

LOW TH CH3 is shown in Figure 54 and described in Table 46.

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Figure 54. LOW_TH_CH3 Register

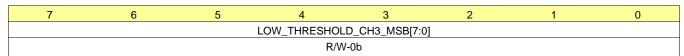


Table 46. LOW_TH_CH3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH3 MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.37 HYSTERESIS_CH4 Register (Address = 0x30) [reset = 0xF0]

HYSTERESIS_CH4 is shown in Figure 55 and described in Table 47.

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Figure 55. HYSTERESIS_CH4 Register

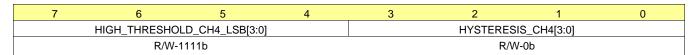


Table 47. HYSTERESIS_CH4 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH4 _LSB[3:0]	R/W	1111b	Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	HYSTERESIS_CH4[3:0]	R/W	Ob	4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.38 HIGH_TH_CH4 Register (Address = 0x31) [reset = 0xFF]

HIGH_TH_CH4 is shown in Figure 56 and described in Table 48.

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Figure 56. HIGH_TH_CH4 Register

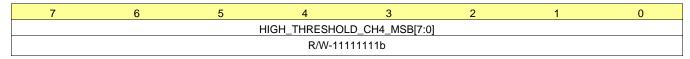




Table 48. HIGH_TH_CH4 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH4	R/W	11111111b	MSB aligned high threshold for analog input. These bits are
	_MSB[7:0]			compared with top 8 bits of ADC conversion result.

8.5.39 EVENT COUNT CH4 Register (Address = 0x32) [reset = 0x0]

EVENT_COUNT_CH4 is shown in Figure 57 and described in Table 49.

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Figure 57. EVENT_COUNT_CH4 Register

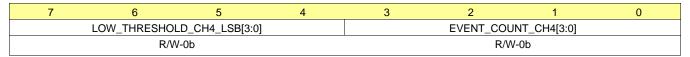


Table 49. EVENT_COUNT_CH4 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH4 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH4[3:0]	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.40 LOW_TH_CH4 Register (Address = 0x33) [reset = 0x0]

LOW_TH_CH4 is shown in Figure 58 and described in Table 50.

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Figure 58. LOW_TH_CH4 Register

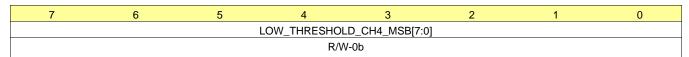


Table 50. LOW_TH_CH4 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH4 _MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.41 HYSTERESIS_CH5 Register (Address = 0x34) [reset = 0xF0]

HYSTERESIS_CH5 is shown in Figure 59 and described in Table 51.

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Figure 59. HYSTERESIS_CH5 Register

7	6	5	4	3	2	1	0
	HIGH_THRESHOL	_D_CH5_LSB[3:0]		HYSTERESIS_CH5[3:0]			
R/W-1111b					R/W	/-0b	

Table 51. HYSTERESIS_CH5 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH5 _LSB[3:0]	R/W		Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.



Table 51. HYSTERESIS_CH5 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
3-0	HYSTERESIS_CH5[3:0]	R/W	0b	4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.42 HIGH_TH_CH5 Register (Address = 0x35) [reset = 0xFF]

HIGH_TH_CH5 is shown in Figure 60 and described in Table 52.

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Figure 60. HIGH_TH_CH5 Register



Table 52. HIGH_TH_CH5 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH5 _MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.43 EVENT_COUNT_CH5 Register (Address = 0x36) [reset = 0x0]

EVENT_COUNT_CH5 is shown in Figure 61 and described in Table 53.

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Figure 61. EVENT_COUNT_CH5 Register

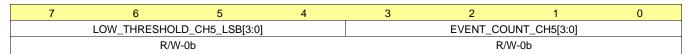


Table 53. EVENT_COUNT_CH5 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH5 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH5[3:0	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.44 LOW_TH_CH5 Register (Address = 0x37) [reset = 0x0]

LOW_TH_CH5 is shown in Figure 62 and described in Table 54.

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Figure 62. LOW_TH_CH5 Register

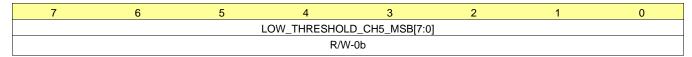


Table 54. LOW_TH_CH5 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH5 _MSB[7:0]	R/W	0b	MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

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8.5.45 HYSTERESIS_CH6 Register (Address = 0x38) [reset = 0xF0]

HYSTERESIS_CH6 is shown in Figure 63 and described in Table 55.

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Figure 63. HYSTERESIS_CH6 Register

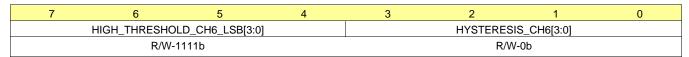


Table 55. HYSTERESIS_CH6 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH6 _LSB[3:0]	R/W	1111b	Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	HYSTERESIS_CH6[3:0]	R/W	Ob	4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.46 HIGH_TH_CH6 Register (Address = 0x39) [reset = 0xFF]

HIGH_TH_CH6 is shown in Figure 64 and described in Table 56.

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Figure 64. HIGH_TH_CH6 Register

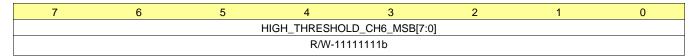


Table 56. HIGH_TH_CH6 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH6 MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.47 EVENT_COUNT_CH6 Register (Address = 0x3A) [reset = 0x0]

EVENT_COUNT_CH6 is shown in Figure 65 and described in Table 57.

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Figure 65. EVENT_COUNT_CH6 Register

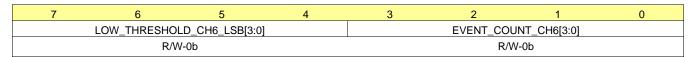


Table 57. EVENT_COUNT_CH6 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH6 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH6[3:0	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.48 LOW_TH_CH6 Register (Address = 0x3B) [reset = 0x0]

LOW_TH_CH6 is shown in Figure 66 and described in Table 58.

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Figure 66. LOW_TH_CH6 Register

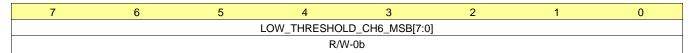


Table 58. LOW_TH_CH6 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH6	R/W	0b	MSB aligned high threshold for analog input. These bits are
	_MSB[7:0]			compared with top 8 bits of ADC conversion result.

8.5.49 HYSTERESIS_CH7 Register (Address = 0x3C) [reset = 0xF0]

HYSTERESIS_CH7 is shown in Figure 67 and described in Table 59.

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Figure 67. HYSTERESIS_CH7 Register

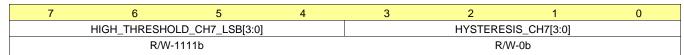


Table 59. HYSTERESIS_CH7 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	HIGH_THRESHOLD_CH7 _LSB[3:0]	R/W	1111b	Lower 4-bits of high threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	HYSTERESIS_CH7[3:0]	R/W	Ob	4-bit hysteresis for high and low thresholds. This 4-bit hysteris is left shifted 3 times and applied on the lower 7-bits of the threshold. Total hysteresis = 7-bits [4-bits, 000b]

8.5.50 HIGH_TH_CH7 Register (Address = 0x3D) [reset = 0xFF]

HIGH_TH_CH7 is shown in Figure 68 and described in Table 60.

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Figure 68. HIGH TH CH7 Register

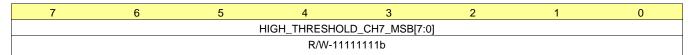


Table 60. HIGH_TH_CH7 Register Field Descriptions

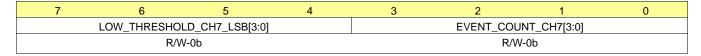
Bit	Field	Туре	Reset	Description
7-0	HIGH_THRESHOLD_CH7 _MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.51 EVENT_COUNT_CH7 Register (Address = 0x3E) [reset = 0x0]

EVENT_COUNT_CH7 is shown in Figure 69 and described in Table 61.

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Figure 69. EVENT_COUNT_CH7 Register



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Table 61. EVENT_COUNT_CH7 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	LOW_THRESHOLD_CH7 _LSB[3:0]	R/W	0b	Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.
3-0	EVENT_COUNT_CH7[3:0	R/W	0b	Configuration for checking 'n+1' consecutive samples above threshold before setting alert flag.

8.5.52 LOW_TH_CH7 Register (Address = 0x3F) [reset = 0x0]

LOW_TH_CH7 is shown in Figure 70 and described in Table 62.

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Figure 70. LOW_TH_CH7 Register

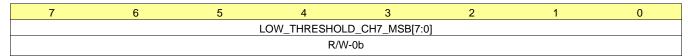


Table 62. LOW_TH_CH7 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LOW_THRESHOLD_CH7 MSB[7:0]	R/W		MSB aligned high threshold for analog input. These bits are compared with top 8 bits of ADC conversion result.

8.5.53 RESERVED Register (Address = 0x4E) [reset = 0x0]

RESERVED is shown in Figure 71 and described in Table 63.

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Figure 71. RESERVED Register

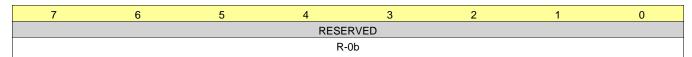


Table 63. RESERVED Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	RESERVED	R		Lower 4-bits of low threshold for analog input. These bits are compared with bits 3:0 of ADC conversion result.

8.5.54 MAX_CH0_LSB Register (Address = 0x60) [reset = 0x0]

MAX_CH0_LSB is shown in Figure 72 and described in Table 64.

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Figure 72. MAX_CH0_LSB Register

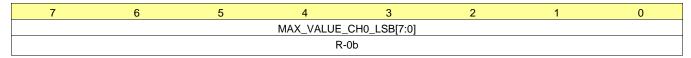


Table 64. MAX_CH0_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH0_LSB[7 :0]	R	Ob	Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.



8.5.55 MAX_CH0_MSB Register (Address = 0x61) [reset = 0x0]

MAX_CH0_MSB is shown in Figure 73 and described in Table 65.

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Figure 73. MAX_CH0_MSB Register

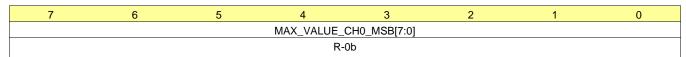


Table 65. MAX_CH0_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH0_MSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.56 MAX_CH1_LSB Register (Address = 0x62) [reset = 0x0]

MAX CH1 LSB is shown in Figure 74 and described in Table 66.

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Figure 74. MAX_CH1_LSB Register

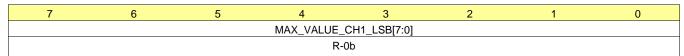


Table 66. MAX_CH1_LSB Register Field Descriptions

Ī	Bit	Field	Туре	Reset	Description
	7-0	MAX_VALUE_CH1_LSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value
		1			to 0.

8.5.57 MAX_CH1_MSB Register (Address = 0x63) [reset = 0x0]

MAX_CH1_MSB is shown in Figure 75 and described in Table 67.

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Figure 75. MAX_CH1_MSB Register

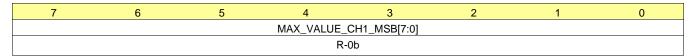


Table 67. MAX_CH1_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH1_MSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.58 MAX CH2 LSB Register (Address = 0x64) [reset = 0x0]

MAX_CH2_LSB is shown in Figure 76 and described in Table 68.

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Figure 76. MAX_CH2_LSB Register

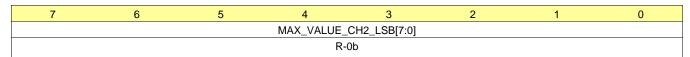


Table 68. MAX_CH2_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH2_LSB[7 :0]	R	Ob	Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.59 MAX_CH2_MSB Register (Address = 0x65) [reset = 0x0]

MAX_CH2_MSB is shown in Figure 77 and described in Table 69.

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Figure 77. MAX_CH2_MSB Register

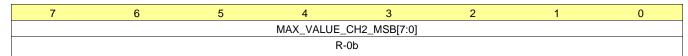


Table 69. MAX_CH2_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH2_MSB[7:0]	R	Ob	Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.60 MAX CH3 LSB Register (Address = 0x66) [reset = 0x0]

MAX_CH3_LSB is shown in Figure 78 and described in Table 70.

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Figure 78. MAX_CH3_LSB Register

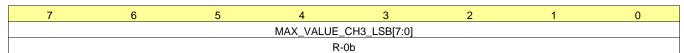


Table 70. MAX_CH3_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH3_LSB[7 :0]	R	Ob	Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.61 MAX_CH3_MSB Register (Address = 0x67) [reset = 0x0]

MAX_CH3_MSB is shown in Figure 79 and described in Table 71.

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Figure 79. MAX CH3 MSB Register

7	6	5	4	3	2	1	0
			MAX_VALUE_	CH3_MSB[7:0]			
			R-	0b			



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Table 71. MAX_CH3_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH3_MSB[7:0]	R	Ob	Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.62 MAX_CH4_LSB Register (Address = 0x68) [reset = 0x0]

MAX_CH4_LSB is shown in Figure 80 and described in Table 72.

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Figure 80. MAX_CH4_LSB Register

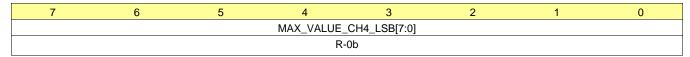


Table 72. MAX_CH4_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH4_LSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.63 MAX_CH4_MSB Register (Address = 0x69) [reset = 0x0]

MAX_CH4_MSB is shown in Figure 81 and described in Table 73.

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Figure 81. MAX_CH4_MSB Register

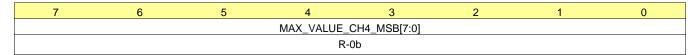


Table 73. MAX_CH4_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH4_MSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.64 MAX_CH5_LSB Register (Address = 0x6A) [reset = 0x0]

MAX_CH5_LSB is shown in Figure 82 and described in Table 74.

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Figure 82. MAX_CH5_LSB Register

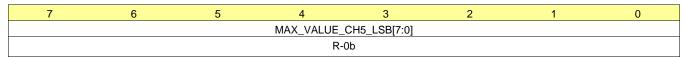


Table 74. MAX_CH5_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH5_LSB[7 :0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.



8.5.65 MAX_CH5_MSB Register (Address = 0x6B) [reset = 0x0]

MAX_CH5_MSB is shown in Figure 83 and described in Table 75.

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Figure 83. MAX_CH5_MSB Register

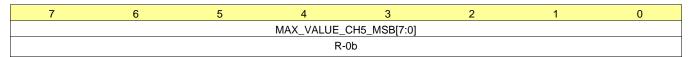


Table 75. MAX_CH5_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH5_MSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.66 MAX_CH6_LSB Register (Address = 0x6C) [reset = 0x0]

MAX CH6 LSB is shown in Figure 84 and described in Table 76.

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Figure 84. MAX_CH6_LSB Register

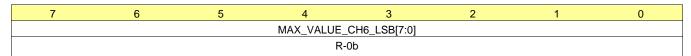


Table 76. MAX_CH6_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH6_LSB[7 :0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.67 MAX_CH6_MSB Register (Address = 0x6D) [reset = 0x0]

MAX_CH6_MSB is shown in Figure 85 and described in Table 77.

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Figure 85. MAX_CH6_MSB Register

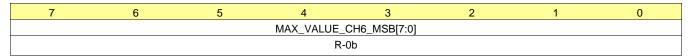


Table 77. MAX_CH6_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH6_MSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.68 MAX_CH7_LSB Register (Address = 0x6E) [reset = 0x0]

MAX_CH7_LSB is shown in Figure 86 and described in Table 78.

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Figure 86. MAX_CH7_LSB Register

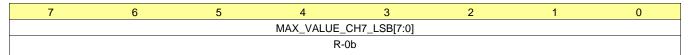


Table 78. MAX_CH7_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH7_LSB[7 :0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0.

8.5.69 MAX_CH7_MSB Register (Address = 0x6F) [reset = 0x0]

MAX_CH7_MSB is shown in Figure 87 and described in Table 79.

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Figure 87. MAX_CH7_MSB Register

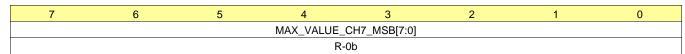


Table 79. MAX_CH7_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MAX_VALUE_CH7_MSB[7:0]	R		Maximum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value
	-			to 0.

8.5.70 MIN CH0 LSB Register (Address = 0x80) [reset = 0xFF]

MIN_CH0_LSB is shown in Figure 88 and described in Table 80.

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Figure 88. MIN_CH0_LSB Register

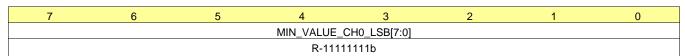


Table 80. MIN_CH0_LSB Register Field Descriptions

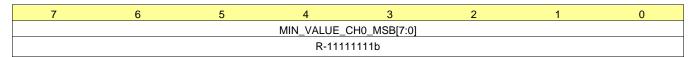
Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH0_LSB[7: 0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.71 MIN_CH0_MSB Register (Address = 0x81) [reset = 0xFF]

MIN_CH0_MSB is shown in Figure 89 and described in Table 81.

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Figure 89. MIN CH0 MSB Register



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Table 81. MIN_CH0_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH0_MSB[7:0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.72 MIN_CH1_LSB Register (Address = 0x82) [reset = 0xFF]

MIN_CH1_LSB is shown in Figure 90 and described in Table 82.

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Figure 90. MIN_CH1_LSB Register

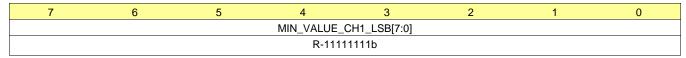


Table 82. MIN_CH1_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH1_LSB[7: 0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.73 MIN_CH1_MSB Register (Address = 0x83) [reset = 0xFF]

MIN_CH1_MSB is shown in Figure 91 and described in Table 83.

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Figure 91. MIN_CH1_MSB Register

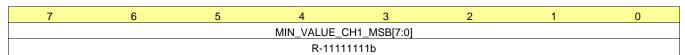


Table 83. MIN_CH1_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH1_MSB[7:0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.74 MIN_CH2_LSB Register (Address = 0x84) [reset = 0xFF]

MIN CH2 LSB is shown in Figure 92 and described in Table 84.

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Figure 92. MIN_CH2_LSB Register

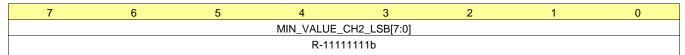


Table 84. MIN_CH2_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH2_LSB[7: 0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

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8.5.75 MIN_CH2_MSB Register (Address = 0x85) [reset = 0xFF]

MIN_CH2_MSB is shown in Figure 93 and described in Table 85.

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Figure 93. MIN_CH2_MSB Register

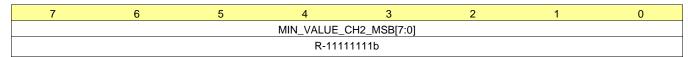


Table 85. MIN_CH2_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH2_MSB[7:0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.76 MIN_CH3_LSB Register (Address = 0x86) [reset = 0xFF]

MIN CH3 LSB is shown in Figure 94 and described in Table 86.

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Figure 94. MIN_CH3_LSB Register

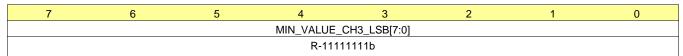


Table 86. MIN_CH3_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH3_LSB[7: 0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.77 MIN_CH3_MSB Register (Address = 0x87) [reset = 0xFF]

MIN_CH3_MSB is shown in Figure 95 and described in Table 87.

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Figure 95. MIN_CH3_MSB Register

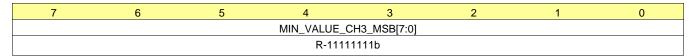


Table 87. MIN_CH3_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH3_MSB[7:0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.78 MIN CH4 LSB Register (Address = 0x88) [reset = 0xFF]

MIN_CH4_LSB is shown in Figure 96 and described in Table 88.

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Figure 96. MIN_CH4_LSB Register

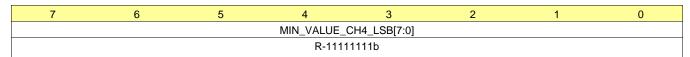


Table 88. MIN_CH4_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH4_LSB[7: 0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.79 MIN_CH4_MSB Register (Address = 0x89) [reset = 0xFF]

MIN_CH4_MSB is shown in Figure 97 and described in Table 89.

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Figure 97. MIN_CH4_MSB Register

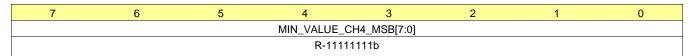


Table 89. MIN_CH4_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH4_MSB[7:0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.80 MIN CH5 LSB Register (Address = 0x8A) [reset = 0xFF]

MIN_CH5_LSB is shown in Figure 98 and described in Table 90.

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Figure 98. MIN_CH5_LSB Register

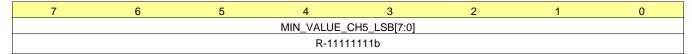


Table 90. MIN_CH5_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH5_LSB[7: 0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.81 MIN_CH5_MSB Register (Address = 0x8B) [reset = 0xFF]

MIN_CH5_MSB is shown in Figure 99 and described in Table 91.

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Figure 99. MIN CH5 MSB Register

7	6	5	4	3	2	1	0
			MIN_VALUE_0	CH5_MSB[7:0]			
			R-1111	l1111b			



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Table 91. MIN_CH5_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH5_MSB[7:0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.82 MIN_CH6_LSB Register (Address = 0x8C) [reset = 0xFF]

MIN_CH6_LSB is shown in Figure 100 and described in Table 92.

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Figure 100. MIN_CH6_LSB Register

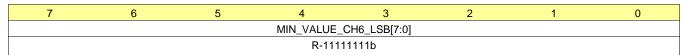


Table 92. MIN_CH6_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH6_LSB[7: 0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.83 MIN_CH6_MSB Register (Address = 0x8D) [reset = 0xFF]

MIN_CH6_MSB is shown in Figure 101 and described in Table 93.

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Figure 101. MIN_CH6_MSB Register

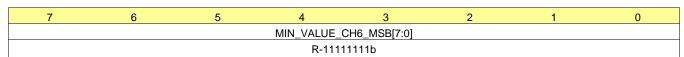


Table 93. MIN_CH6_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH6_MSB[7:0]	R		Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.84 MIN_CH7_LSB Register (Address = 0x8E) [reset = 0xFF]

MIN_CH7_LSB is shown in Figure 102 and described in Table 94.

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Figure 102. MIN_CH7_LSB Register

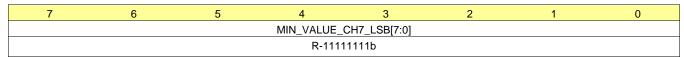


Table 94. MIN_CH7_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	MIN_VALUE_CH7_LSB[7: 0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.



8.5.85 MIN_CH7_MSB Register (Address = 0x8F) [reset = 0xFF]

MIN_CH7_MSB is shown in Figure 103 and described in Table 95.

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Figure 103. MIN_CH7_MSB Register

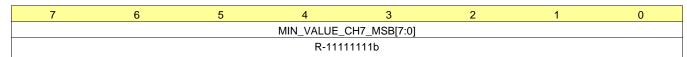


Table 95. MIN_CH7_MSB Register Field Descriptions

Bi	it	Field	Туре	Reset	Description
7-0	0	MIN_VALUE_CH7_MSB[7 :0]	R	11111111b	Minimum code recorded on the analog input channel from the last time this register was read. Reading the register will reset the value to 0xFF.

8.5.86 RECENT_CH0_LSB Register (Address = 0xA0) [reset = 0x0]

RECENT CH0 LSB is shown in Figure 104 and described in Table 96.

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Figure 104. RECENT_CH0_LSB Register

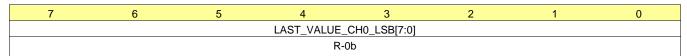


Table 96. RECENT_CH0_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH0_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.87 RECENT CH0 MSB Register (Address = 0xA1) [reset = 0x0]

RECENT_CH0_MSB is shown in Figure 105 and described in Table 97.

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Figure 105. RECENT_CH0_MSB Register

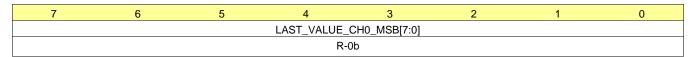


Table 97. RECENT_CH0_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH0_MSB [7:0]	R	0b	MSB aligned first 8 bits of the last result for this analog input channel.

8.5.88 RECENT_CH1_LSB Register (Address = 0xA2) [reset = 0x0]

RECENT_CH1_LSB is shown in Figure 106 and described in Table 98.

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Figure 106. RECENT_CH1_LSB Register

7	6	5	4	3	2	1	0
LAST_VALUE_CH1_LSB[7:0]							
			R-	-0b			

Table 98. RECENT_CH1_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH1_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.89 RECENT_CH1_MSB Register (Address = 0xA3) [reset = 0x0]

RECENT_CH1_MSB is shown in Figure 107 and described in Table 99.

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Figure 107. RECENT_CH1_MSB Register

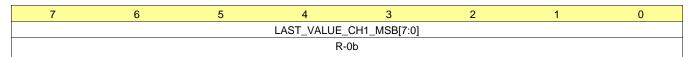


Table 99. RECENT_CH1_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH1_MSB [7:0]	R		MSB aligned first 8 bits of the last result for this analog input channel.

8.5.90 RECENT_CH2_LSB Register (Address = 0xA4) [reset = 0x0]

RECENT_CH2_LSB is shown in Figure 108 and described in Table 100.

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Figure 108. RECENT_CH2_LSB Register

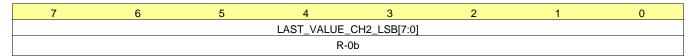


Table 100. RECENT CH2 LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH2_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.91 RECENT_CH2_MSB Register (Address = 0xA5) [reset = 0x0]

RECENT_CH2_MSB is shown in Figure 109 and described in Table 101.

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Figure 109. RECENT_CH2_MSB Register

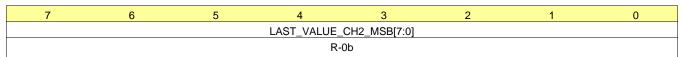




Table 101. RECENT_CH2_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH2_MSB	R	0b	MSB aligned first 8 bits of the last result for this analog input
	[7:0]			channel.

8.5.92 RECENT_CH3_LSB Register (Address = 0xA6) [reset = 0x0]

RECENT_CH3_LSB is shown in Figure 110 and described in Table 102.

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Figure 110. RECENT_CH3_LSB Register

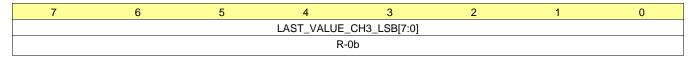


Table 102. RECENT_CH3_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH3_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.93 RECENT_CH3_MSB Register (Address = 0xA7) [reset = 0x0]

RECENT_CH3_MSB is shown in Figure 111 and described in Table 103.

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Figure 111. RECENT_CH3_MSB Register

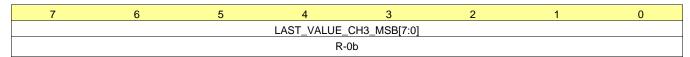


Table 103. RECENT_CH3_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH3_MSB	R	0b	MSB aligned first 8 bits of the last result for this analog input
	[7:0]			channel.

8.5.94 RECENT_CH4_LSB Register (Address = 0xA8) [reset = 0x0]

RECENT_CH4_LSB is shown in Figure 112 and described in Table 104.

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Figure 112. RECENT_CH4_LSB Register

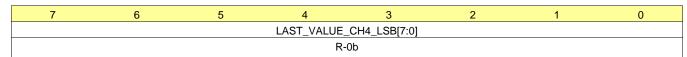


Table 104. RECENT_CH4_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH4_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.



8.5.95 RECENT_CH4_MSB Register (Address = 0xA9) [reset = 0x0]

RECENT_CH4_MSB is shown in Figure 113 and described in Table 105.

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Figure 113. RECENT_CH4_MSB Register

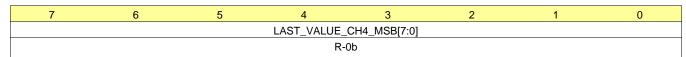


Table 105. RECENT_CH4_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH4_MSB	R	0b	MSB aligned first 8 bits of the last result for this analog input
	[7:0]			channel.

8.5.96 RECENT_CH5_LSB Register (Address = 0xAA) [reset = 0x0]

RECENT_CH5_LSB is shown in Figure 114 and described in Table 106.

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Figure 114. RECENT_CH5_LSB Register

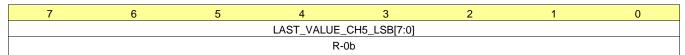


Table 106. RECENT_CH5_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH5_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.97 RECENT CH5 MSB Register (Address = 0xAB) [reset = 0x0]

RECENT_CH5_MSB is shown in Figure 115 and described in Table 107.

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Figure 115. RECENT_CH5_MSB Register

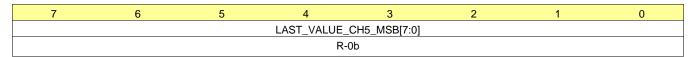


Table 107. RECENT_CH5_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH5_MSB [7:0]	R	0b	MSB aligned first 8 bits of the last result for this analog input channel.

8.5.98 RECENT_CH6_LSB Register (Address = 0xAC) [reset = 0x0]

RECENT_CH6_LSB is shown in Figure 116 and described in Table 108.

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Figure 116. RECENT_CH6_LSB Register

7	6	5	4	3	2	1	0
LAST_VALUE_CH6_LSB[7:0]							
			R-	0b			

Table 108. RECENT_CH6_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH6_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.99 RECENT_CH6_MSB Register (Address = 0xAD) [reset = 0x0]

RECENT_CH6_MSB is shown in Figure 117 and described in Table 109.

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Figure 117. RECENT_CH6_MSB Register

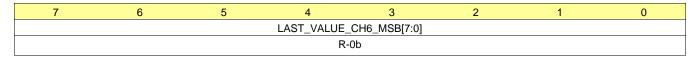


Table 109. RECENT_CH6_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH6_MSB	R	0b	MSB aligned first 8 bits of the last result for this analog input
	[7:0]			channel.

8.5.100 RECENT_CH7_LSB Register (Address = 0xAE) [reset = 0x0]

RECENT_CH7_LSB is shown in Figure 118 and described in Table 110.

Return to the Summary Table.

Figure 118. RECENT_CH7_LSB Register

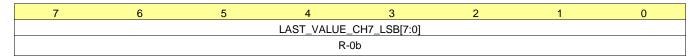


Table 110. RECENT_CH7_LSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH7_LSB[7:0]	R	0b	Next 8 bits of the last result for this analog input channel.

8.5.101 RECENT_CH7_MSB Register (Address = 0xAF) [reset = 0x0]

RECENT_CH7_MSB is shown in Figure 119 and described in Table 111.

Return to the Summary Table.

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Figure 119. RECENT_CH7_MSB Register

7	6	5	4	3	2	1	0
LAST_VALUE_CH7_MSB[7:0]							
			R-	0b			



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Table 111. RECENT_CH7_MSB Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	LAST_VALUE_CH7_MSB [7:0]	R		MSB aligned first 8 bits of the last result for this analog input channel.

8.5.102 GPO0_TRIG_EVENT_SEL Register (Address = 0xC3) [reset = 0x0]

GPO0_TRIG_EVENT_SEL is shown in Figure 120 and described in Table 112.

Return to the Summary Table.

Figure 120. GPO0_TRIG_EVENT_SEL Register



Table 112. GPO0_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO0_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO0.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO0 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO0 output.

8.5.103 GPO1_TRIG_EVENT_SEL Register (Address = 0xC5) [reset = 0x0]

GPO1_TRIG_EVENT_SEL is shown in Figure 121 and described in Table 113.

Return to the Summary Table.

Figure 121. GPO1_TRIG_EVENT_SEL Register



Table 113. GPO1_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO1_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO1.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO1 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO1 output.

8.5.104 GPO2_TRIG_EVENT_SEL Register (Address = 0xC7) [reset = 0x0]

GPO2_TRIG_EVENT_SEL is shown in Figure 122 and described in Table 114.

Return to the Summary Table.

Figure 122. GPO2_TRIG_EVENT_SEL Register

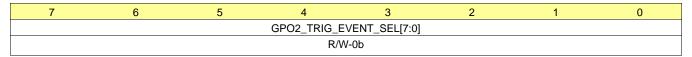




Table 114. GPO2_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO2_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO2.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO2 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO2 output.

8.5.105 GPO3_TRIG_EVENT_SEL Register (Address = 0xC9) [reset = 0x0]

GPO3_TRIG_EVENT_SEL is shown in Figure 123 and described in Table 115.

Return to the Summary Table.

Figure 123. GPO3_TRIG_EVENT_SEL Register



Table 115. GPO3_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO3_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO3.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO3 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO3 output.

8.5.106 GPO4_TRIG_EVENT_SEL Register (Address = 0xCB) [reset = 0x0]

GPO4_TRIG_EVENT_SEL is shown in Figure 124 and described in Table 116.

Return to the Summary Table.

Figure 124. GPO4_TRIG_EVENT_SEL Register



Table 116. GPO4_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO4_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO4.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO4 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO4 output.

8.5.107 GPO5_TRIG_EVENT_SEL Register (Address = 0xCD) [reset = 0x0]

GPO5_TRIG_EVENT_SEL is shown in Figure 125 and described in Table 117.

Return to the Summary Table.



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Figure 125. GPO5 TRIG EVENT SEL Register

7	6	5	4	3	2	1	0			
GPO5_TRIG_EVENT_SEL[7:0]										
	R/W-0b									

Table 117. GPO5_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO5_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO5.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO5 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO5 output.

8.5.108 GPO6_TRIG_EVENT_SEL Register (Address = 0xCF) [reset = 0x0]

GPO6_TRIG_EVENT_SEL is shown in Figure 126 and described in Table 118. Return to the Summary Table.

Figure 126. GPO6_TRIG_EVENT_SEL Register



Table 118. GPO6_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO6_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO6.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO6 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO6 output.

8.5.109 GPO7_TRIG_EVENT_SEL Register (Address = 0xD1) [reset = 0x0]

GPO7_TRIG_EVENT_SEL is shown in Figure 127 and described in Table 119.

Return to the Summary Table.

Figure 127. GPO7_TRIG_EVENT_SEL Register



Table 119. GPO7_TRIG_EVENT_SEL Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO7_TRIG_EVENT_SE L[7:0]	R/W	0b	Select the inputs AIN/GPIO[7:0], analog or digital, which can trigger an event based update on GPO7.
				0b = Alert flags for the AIN/GPIO corresponding to this bit do not trigger GPO7 output.
				1b = Alert flags for the AIN/GPIO corresponding to this bit do trigger GPO7 output.



8.5.110 GPO_TRIGGER_CFG Register (Address = 0xE9) [reset = 0x0]

GPO_TRIGGER_CFG is shown in Figure 128 and described in Table 120.

Return to the Summary Table.

Figure 128. GPO_TRIGGER_CFG Register

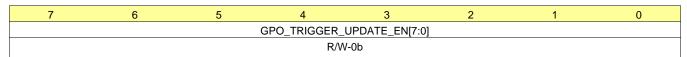


Table 120. GPO_TRIGGER_CFG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO_TRIGGER_UPDAT E_EN[7:0]	R/W	0b	Update digital outputs GPO[7:0] when the corresponding trigger is set.
				0b = Digital output is not updated in response to the alert flags.
				1b = Digital output is updated when the corresponding alert flags are set. Configure GPOx_TRIG_EVENT_SEL register to select which alert flags can trigger an update on the desired GPO.

8.5.111 GPO_VALUE_TRIG Register (Address = 0xEB) [reset = 0x0]

GPO_VALUE_TRIG is shown in Figure 129 and described in Table 121.

Return to the Summary Table.

Figure 129. GPO_VALUE_TRIG Register

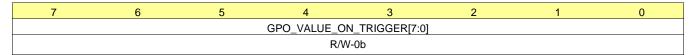


Table 121. GPO_VALUE_TRIG Register Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	GPO_VALUE_ON_TRIGG ER[7:0]	R/W		Value to be set on digital outputs GPO[7:0] when the corresponding trigger occurs. GPO update on alert flags must be enabled in the corresponding bit in the GPO_TRIGGER_CFG register. 0b = Digital output is set to logic 0. 1b = Digital output is set to logic 1.



9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The two primary circuits required to maximize the performance of a high-precision, successive approximation register analog-to-digital converter (SAR ADC) are the input driver and the reference driver circuits. This section details some general principles for designing the input driver circuit, reference driver circuit, and provides some application circuits designed for the ADS7038.

9.2 Typical Applications

9.2.1 Mixed-Channel Configuration

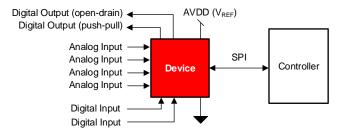


Figure 130. DAQ Circuit: Single-Supply DAQ

9.2.1.1 Design Requirements

The goal of this application is to configure some channels of the ADS7038 as digital inputs, open-drain digital outputs, and push-pull digital outputs.

9.2.1.2 Detailed Design Procedure

The ADS7038 can support GPIO functionality at each input pin. Any analog input pin can be independently configured as a digital input, a digital open-drain output, or a digital push-pull output though the PIN_CFG and GPIO CFG registers; see Table 3.

9.2.1.2.1 Digital Input

The digital input functionality can be used to monitor a signal within the system. Figure 131 illustrates that the state of the digital input can be read from the GPI_VALUE register.



Typical Applications (continued)

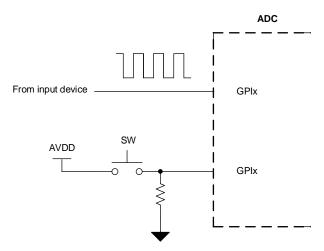


Figure 131. Digital Input

9.2.1.2.2 Digital Open-Drain Output

The channels of the ADS7038 can be configured as digital open-drain outputs supporting an output voltage up to 5.5 V. An open-drain output, as shown in Figure 132, consists of an internal FET (Q) connected to ground. The output is idle when not driven by the device, which means Q is off and the pullup resistor, R_{PULL_UP}, connects the GPOx node to the desired output voltage. The output voltage can range anywhere up to 5.5 V, depending on the external voltage that the GPIOx is pulled up to. When the device is driving the output, Q turns on, thus connecting the pullup resistor to ground and bringing the node voltage at GPOx low.

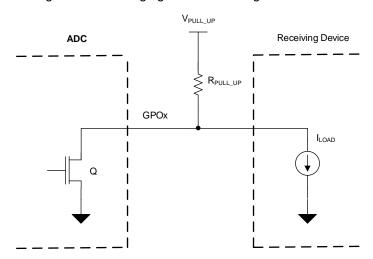


Figure 132. Digital Open-Drain Output

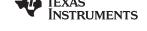
The minimum value of the pullup resistor, as calculated in Equation 3, is given by the ratio of V_{PULL_UP} and the maximum current supported by the device digital output (5 mA).

$$R_{MIN} = (V_{PULL_UP} / 5 \text{ mA}) \tag{3}$$

The maximum value of the pullup resistor, as calculated in Equation 4, depends on the minimum input current requirement, I_{LOAD} , of the receiving device driven by this GPIO.

$$R_{MAX} = (V_{PULL\ UP} / I_{LOAD}) \tag{4}$$

Select $R_{PULL\ UP}$ such that $R_{MIN} < R_{PULL\ UP} < R_{MAX}$.



Typical Applications (continued)

9.2.2 Digital Push-Pull Output Configuration

The channels of the ADS7038 can be configured as digital push-pull outputs supporting an output voltage up to AVDD. As shown in Figure 133, a push-pull output consists of two mirrored opposite bipolar transistors, Q1 and Q2. The device can both source and sink current because only one transistor is on at a time (either Q2 is on and pulls the output low, or Q1 is on and sets the output high). A push-pull configuration always drives the line opposed to an open-drain output where the line is left floating.

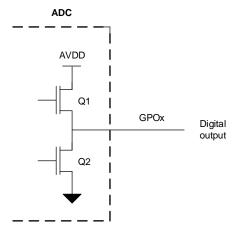


Figure 133. Digital Push-Pull Output

10 Power Supply Recommendations

10.1 AVDD and DVDD Supply Recommendations

The ADS7038 has two separate power supplies: AVDD and DVDD. The device operates on AVDD; DVDD is used for the interface circuits. For supplies greater than 2.35 V, AVDD and DVDD can be shorted externally if single-supply operation is desired. The AVDD supply also defines the full-scale input range of the device. Decouple the AVDD and DVDD pins individually, as shown in Figure 134, with 1-µF ceramic decoupling capacitors. The minimum capacitor value required for AVDD and DVDD is 200 nF and 20 nF, respectively. If both supplies are powered from the same source, a minimum capacitor value of 220 nF is required for decoupling.

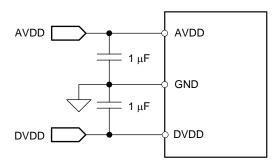


Figure 134. Power-Supply Decoupling



11 Layout

11.1 Layout Guidelines

Figure 135 shows a board layout example for the ADS7038. Avoid crossing digital lines with the analog signal path and keep the analog input signals and the AVDD supply away from noise sources.

Use $1-\mu F$ ceramic bypass capacitors in close proximity to the analog (AVDD) and digital (DVDD) power-supply pins. Avoid placing vias between the AVDD and DVDD pins and the bypass capacitors. Connect the GND pin to the ground plane using short, low-impedance paths. The AVDD supply voltage also functions as the reference voltage for the ADS7038. Place the decoupling capacitor (C_{REF}) for AVDD close to the device AVDD and GND pins and connect C_{REF} to the device pins with thick copper tracks.

11.2 Layout Example

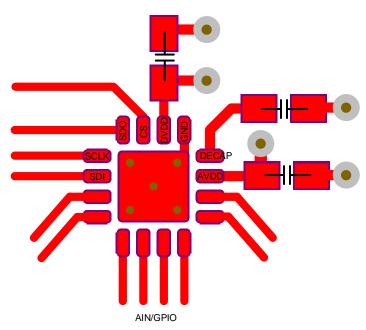


Figure 135. Example Layout

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12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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Design Support TI's Design Support Quickly find helpful E2E forums along with design support tools and contact information for technical support.

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGE OPTION ADDENDUM

3-Jul-2019

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
ADS7038IRTER	PREVIEW	WQFN	RTE	16	3000	TBD	Call TI	Call TI	-40 to 125		
ADS7038IRTET	PREVIEW	WQFN	RTE	16	250	TBD	Call TI	Call TI	-40 to 125		
XADS7038IRTER	ACTIVE	WQFN	RTE	16	3000	TBD	Call TI	Call TI	-40 to 125		Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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RTE (S-PWQFN-N16)

PLASTIC QUAD FLATPACK NO-LEAD



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. Quad Flatpack, No-leads (QFN) package configuration.
- The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
- E. Falls within JEDEC MO-220.



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